



Please type a plus sign (+) inside this box [+]

PTO/SB/05 (12/97)

Approved for use through 09/30/00. OMB 0651-0032

Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

UTILITY PATENT APPLICATION TRANSMITTAL

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Attorney Docket No. 03588.P002

Total Pages 5

First Named Inventor or Application Identifier Kevin Brehmer

Express Mail Label No. EL370843369US

1542 U.S. PTO
09/352494

07/13/99

ADDRESS TO: Assistant Commissioner for Patents
Box Patent Application
Washington, D. C. 20231

APPLICATION ELEMENTS

See MPEP chapter 600 concerning utility patent application contents.

1. X Fee Transmittal Form
(Submit an original, and a duplicate for fee processing)
2. X Specification (Total Pages 43)
(preferred arrangement set forth below)
 - Descriptive Title of the Invention
 - Cross References to Related Applications
 - Statement Regarding Fed sponsored R & D
 - Reference to Microfiche Appendix
 - Background of the Invention
 - Brief Summary of the Invention
 - Brief Description of the Drawings (if filed)
 - Detailed Description
 - Claims
 - Abstract of the Disclosure
3. X Drawings(s) (35 USC 113) (Total Sheets 17)
4. X Oath or Declaration (Total Pages 4 unsigned)
 - a. Newly Executed (Original or Copy)
 - b. Copy from a Prior Application (37 CFR 1.63(d))
(for Continuation/Divisional with Box 17 completed) (**Note Box 5 below**)
 - i. DELETIONS OF INVENTOR(S) Signed statement attached deleting inventor(s) named in the prior application, see 37 CFR 1.63(d)(2) and 1.33(b).
5. Incorporation By Reference (useable if Box 4b is checked)
The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.
6. Microfiche Computer Program (Appendix)

7. ☐ Nucleotide and/or Amino Acid Sequence Submission
(if applicable, all necessary)
a. ☐ Computer Readable Copy
b. ☐ Paper Copy (identical to computer copy)
c. ☐ Statement verifying identity of above copies

ACCOMPANYING APPLICATION PARTS

8. ☐ Assignment Papers (cover sheet & documents(s))
9. ☐ a. 37 CFR 3.73(b) Statement (where there is an assignee)
☐ b. Power of Attorney
10. ☐ English Translation Document (if applicable)
11. ☐ a. Information Disclosure Statement (IDS)/PTO-1449
☐ b. Copies of IDS Citations
12. ☐ Preliminary Amendment
13. ☒ Return Receipt Postcard (MPEP 503) (Should be specifically itemized)
14. ☒ a. Small Entity Statement(s)
☐ b. Statement filed in prior application, Status still proper and desired
15. ☐ Certified Copy of Priority Document(s) (if foreign priority is claimed)
16. ☒ Other: Express Certificate of Mailing

17. **If a CONTINUING APPLICATION**, check appropriate box and supply the requisite information:
☐ Continuation ☐ Divisional ☐ Continuation-in-part (CIP)
of prior application No: _____

18. Correspondence Address

☐ Customer Number or Bar Code Label _____
(Insert Customer No. or Attach Bar Code Label here)
or

☒ Correspondence Address Below

NAME Dag H. Johansen (Reg. No.: 36,172)
BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP

ADDRESS 12400 Wilshire Boulevard
Seventh Floor

CITY Los Angeles STATE California ZIP CODE 90025-1026

Country U.S.A. TELEPHONE (408) 720-8598 FAX (408) 720-9397

12/01/97

Applicant or Patentee: Brehmer et al. Attorney's
Serial or Patent No.: Not assigned Docket No. 03588.P002X
Filed or Issued: Herewith
For: Method and Architecture for an Improved CMOS Color Image Sensor

VERIFIED STATEMENT (DECLARATION) CLAIMING SMALL ENTITY STATUS
37 CFR 1.9 (f) and 1.27(c) - - SMALL BUSINESS CONCERN

I hereby declare that I am:

- [] the owner of the small business concern identified below:
[X] an official of the small business concern empowered to act on behalf of the
concern identified below:

NAME OF CONCERN: KEVIN E. BREHMER
ADDRESS OF CONCERN: 1500 E. HAMILTON AVENUE, SUITE 211, CAMPBELL, CA 95008

I hereby declare that the above identified small business concern qualifies as a small business concern as defined in 13 CFR 121.3-18, and reproduced in 37 CFR 1.9(d), for purposes of paying reduced fees under Section 41(a) and (b) of Title 35, United States Code, in that the number of employees of the concern, including those of its affiliates, does not exceed 500 persons. For purposes of this statement, (1) the number of employees of the business concern is the average over the previous fiscal year of the concern of the persons employed on a full-time, part-time or temporary basis during each of the pay periods of the fiscal year, and (2) concerns are affiliates of each other when either, directly or indirectly, one concern controls or has the power to control the other, or a third party or parties controls or has the power to control both.

I hereby certify that to the best of my knowledge and belief rights under contract or law have been conveyed to and remain with the small business concern identified above with regard to the invention entitled Method and Architecture for an Improved CMOS Color Image Sensor
by inventor(s) Kevin E. Brehmer and Rudolph A. Wiedemann
described in

- [X] the specification being filed herewith
[] application serial no. _____, filed _____
[] patent no. _____, issued _____

and I have reviewed the document that evidences the conveyance of those rights. That document

- [X] is being filed herewith.
[] was recorded in the Patent and Trademark Office on _____, 19 ____
at reel _____ and frame _____.

If the rights held by the above-identified small business concern are not exclusive, each individual, concern or organization having rights to the invention is listed below and **no rights to the invention are held by any person, other than the inventor, who could not qualify as a small business concern under 37 CFR 1.9(d) or by any concern which would not qualify as a small business concern under 347 CFR 1.9(d) or a non-profit organization under 37 CFR 1.9(e).** NOTE: Separate verified statements are required from each named person, concern or organization having rights to the invention averring to their status as small entities. (37 CFR 1.27)

NAME: _____

ADDRESS: _____

☐ Individual ☐ Small Business Concern ☐ Non-Profit Organization

NAME: _____

ADDRESS: _____

☐ Individual ☐ Small Business Concern ☐ Non-Profit Organization

I acknowledge the duty to file, in this application or patent, notification of any change in status resulting in loss of entitlement to small entity status prior to paying, or at the time of paying, the earliest of the issue fee or any maintenance fee due after the date on which status as a small entity is no longer appropriate. (37 CFR 1.28(b))

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereon, or any patent to which this verified statement is directed.

NAME OF PERSON SIGNING: KEVIN E. BREHMER

TITLE OF PERSON OTHER THAN OWNER: _____

ADDRESS OF PERSON SIGNING: 1500 E. HAMILTON AVENUE, SUITE 211, CAMPBELL, CA 95008

SIGNATURE: _____ DATE: _____

APPLICATION FOR UNITED STATES LETTERS PATENT

FOR

**Method and Architecture for an
Improved CMOS Color Image Sensor**

Inventors: KEVIN BREHMER
 Rudolph A. Wiedemann

Prepared by:
Blakely, Sokoloff, Taylor & Zafman
1279 Oakmead Parkway
Sunnyvale, California 94086
(408) 720-8598

"Express Mail" mailing label number EL370843369US
Date of Deposit 7/13/99
I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the Commissioner of Patents and Trademarks, Washington, D.C. 20231.
GRACE R. CRO
(Typed or printed name of person mailing paper or fee)
[Signature]
(Signature of person mailing papers or fee)

Method and Architecture for an Improved CMOS Color Image Sensor

CLAIM OF PRIORITY

5 This application claims priority based on the provisional application with serial No. 60/092,533 that was filed on July 13, 1998 with the U.S. Patent and Trademark Office entitled "Method and Apparatus for A CMOS Image Sensor With A Pixel Processor", which is hereby incorporated by reference for all purposes.

FIELD OF THE INVENTION

10 The present invention generally relates to image sensors and more particularly relates to a method and architecture for an improved CMOS color image sensor having a pixel processor integrated therewith. The improved CMOS color image sensor provides dynamic access to photo-sensors therein for improved signal throughput and, along with the pixel processor, for tasks including preview, digital zoom, shuttle
15 control, color balance, and gray-scale readout.

BACKGROUND OF THE INVENTION

 Digital photography is one of the most exciting technologies that emerged in the past ten years. With the appropriate hardware and software (and a little knowledge), anyone can put the principles of digital photography to work. Digital still
20 and video cameras are on the cutting edge of digital photography. Recent product introductions, technological advancements, and price cuts, along with the emergence of

email and the World Wide Web, have helped make the digital cameras the hottest new category of consumer electronics products.

Unlike traditional cameras that use film to store an image, digital cameras use a photosensitive device called an image sensor. Until recently, the dominant and nearly only solid-state image sensor technology was the charge-coupled device (CCD). However, most microprocessors, logic circuits, ASICs (application-specific integrated circuits), and memory circuits are based on Complementary Metal Oxide Semiconductor (CMOS) technology. Logically, CMOS will be used for image sensors in a rapidly expanding sphere of applications.

Several important factors have contributed to the emergence of CMOS image sensor arrays at this time rather than 10 years ago. The primary factor is a recent demand by customers for portable, low power, miniaturized digital imaging systems. A second important factor is that current CMOS technology offers submicron feature sizes and low defect and contamination levels, respectively permitting cost-effective pixel sizes and low junction leakage (or dark) current. In addition, threshold voltage control and uniformity is stable and reproducible. The third important factor is that new circuit techniques have been invented or have been adopted from CCD signal processing that permit both low noise and high-dynamic-range imaging that is competitive with the best CCDs.

A CMOS image sensor array comprises millions of photocells or photo sensors. Each of the photo sensors produces an electronic signal representing the intensity of the light that reflects from a target and falls on it by accumulating a charge; generally the more light, the higher the charge is. After the light integration, the

electronic signals from all of the photo sensors are readout and then digitized through an analog-to-digital converter to produce digital image of the target.

Figure 1 illustrates an exemplary use of a CMOS image sensor in an imaging sensing system **100** such as a digital camera. The image sensing system **100** comprises an optical system **132** for focusing an image onto image sensor array device **130**. Readout circuitry **133** reads an electronic image information from the image sensor array **130**. The readout circuitry **133** passes analog image signal representing the target image is to an analog-to-digital converter (A/D) **140** for digitization.

The A/D converter **140** digitizes the analog image signal from the image sensor **130** to create a digitized signal that can be appropriately and subsequently stored in memory **150**. Typically, an imaging system **100** further comprises a digital signal processing circuitry **160** that performs various processing tasks to put the digital image into a suitable form. For example, the digital signal processing circuitry **160** may adjust, correct, preprocess and compress the digitized signal to eventually output an appropriate digital image or signal. In the embodiment of **Figure 1**, the digital signal processing circuitry **160** performs operations necessary to place the image signal into suitable form for display onto display **171** using display driver **170**.

As shown in **Figure 1**, traditional image sensor arrays could only output image signals that required further signal conditioning before such image signals could be used. For example, the imaging system **100** required digital signal processing circuitry **160** to processes the image signal before it could be passed to the display system. To simplify the design of an image system, it would be desirable to eliminate or reduce the need for a digital signal processor in an imaging system.

SUMMARY OF THE INVENTION

According to the principles of this invention, an improved CMOS image sensor array is disclosed. The improved CMOS image sensor array comprises a pair of controllable column and row decoders, a signal conditioning circuit and a pixel processor in addition to an array of photo sensors. With the pair of controllable column and row decoders, the improved CMOS image sensor array can selectively and dynamically access particular desired photo sensors. Thus, applications that do not require the full set of signals from the entire array of photo sensors can access the desired photo sensors. Along with an on-chip memory, digitized signals from the selected photo sensors can be processed in the pixel processor for auto focus, pixel decimation, pixel interpolation, pixel averaging, data conversation, and compression. The conditioning circuit comprises a correlated double sampling circuit and a programmable gain amplifier. The combination of the two circuits makes it possible to provide color balancing and auto-exposure control in a more precise manner and further facilitates a wider dynamic range by the analog-to-digital converters.

The advantages of the present invention are numerous. Different embodiments or implementations including methods and circuit architecture may yield one or more of the following advantages. By selectively and dynamically accessing signals in the photo sensors, transmission of only a smaller set of useful signals reduces the bandwidth of the buses that otherwise must be high enough to accommodate all the signals readout from the photo sensors. Another important feature of the present invention is the high signal throughput for applications that require only a small selected set of pixel signals from the photo sensor array. For example, a small number of pixel signals may be very quickly read out and processed for applications such as image

preview, color balancing, exposure setting, and auto focus. Another important feature in the present invention is the use of the pixel processor that can be configured to perform many internal processing of the image data. Consequently, the design complexity of an overall imaging system using the present invention is considerably reduced and the performance thereof is substantially increased. For example, the image sensor array of the present invention can output digital image information that can be directly used to drive a digital image display.

Other objects and advantage together with the foregoing are attained in the exercise of the invention in the following description and resulting in the embodiment

10 illustrated in the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

These and other features, aspects, and advantages of the present invention will become better understood with regard to the following description, appended claims, and accompanying drawings where:

5 **Figure 1** shows an exemplary use of a CMOS image sensor in an imaging sensing system that comprises an image sensor array device and an optical system;

Figure 2A shows a schematic diagram of a system that uses involving a digital imaging system;

Figure 2B illustrates a Bayer pattern two-dimensional image sensor array
10 that comprises a plurality of photo sensors fabricated on a Complementary Metal-Oxide Semiconductor (CMOS) device;

Figure 2C illustrates a typical CMOS image sensor array;

Figure 3A shows a functional block diagram of an improved image sensor device according to one embodiment of the present invention;

15 **Figure 3B** depicts the Bayer arrangement and each column of the photo sensors is coupled to a readout bus;

Figure 4 shows the reduced design complexity of an imaging system employing the improved image sensor of the present invention;

Figure 5A shows an image sensor having 1024 by 768 photo sensors,
20 wherein each of the photo sensors is addressed by a pair of column address decoder and row address decoder;

Figure 5B illustrates a highlighted serial pixel decimation signal for the image sensor of **Figure 5A**;

Figure 6A illustrates a flowchart to illustrate the process for reading out electronic signals from a region of interest (ROI) for auto focus, digital zoom and other similar applications;

Figure 6B illustrates an exemplary approach based on derivative calculations for the pixel processor to cause the imaging system to focus on the target consequently to produce in-focus images;

Figure 7A illustrates that an image sensor is focused on a house but the user is interested in viewing the front window portion;

Figure 7B shows the decimation process flowchart according to one embodiment of the present invention;

Figure 7C shows an example of a small portion of signals from the image sensor being enlarged by the interpolation process;

Figure 8A illustrates a first example signals from an array of photo sensors are being decimated;

Figure 8B illustrates a conceptual diagram of pixels being decimated;

Figure 9A illustrates four neighboring pixel signals from the R, G, and B photo sensors being co-sited.

Figure 9B illustrates four neighboring pixel signals from the R, G, and B photo sensors being co-sited.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENT

In the following detailed description of the present invention, numerous specific details are set forth in order to provide a thorough understanding of the present invention. However, it will become obvious to those skilled in the art that the present invention may be practiced without these specific details. The description and representation herein are the common means used by those experienced or skilled in the art to most effectively convey the substance of their work to others skilled in the art. In other instances, well-known methods, procedures, components, and circuitry have not been described in detail to obscuring aspects of the present invention.

Color Images and CMOS Sensors

Referring now to the drawings, in which like numerals refer to like parts throughout the several views. **Figure 2A** shows a schematic diagram of a system involving a digital imaging system **200**. Under either natural or man-made illumination, optics unit **202** collects light reflected from an object **104** and focuses the reflected light onto an image sensor **204**. The imaging system **200** subsequently produces digital image data **108** that may be used to display a representation of object **104** on a computer **206**. Alternatively, imaging system **200** may produce video signals (sequence of temporal images) **210** that may be displayed on a television system **208**.

Depending on the applications, the imaging system **200** (that may be a digital still camera or a digital video camera) may produce a gray-scale or color image. In the case of a gray-scale image, digital image data **108** comprises a plurality of pixels wherein each pixel is represented by a numerical value. The pixel numerical value represents the intensity of incident light impinged upon the image sensor **204** in imaging

system **200** from a corresponding location on object **104**. For example, if the object **104** is an 8.5-inch by 11-inch paper; resultant image may have a size 850 by 1100 pixels and is represented in 8-bit format wherein each digital pixel value ranges from 0 to 255. This means that each square inch of scanning object **210** is represented by 100 by 100 pixels.

- 5 If all the pixels from a particular square inch report a value of 255, then the square inch in object **210** is white. Similarly, if all the pixels for a square inch report an output value of zero ("0"), then square inch in object **104** is dark. It can be understood that any pixels having a value between 0 and 255, i.e. the gray scale, represent the light intensity variations of the object **104**.

- 10 When the imaging system **200** reproduces colors of the object **104**, the digital image data **108** from imaging system **200** typically comprises a set of three different light intensity images for three different colors: red, green, and blue. Each of the three light intensity images being an array or matrix of pixels having a value between 0 to 255 when presented in an 8-bit precision format. When the three pixel matrixes are
- 15 combined, each color pixel $C(x, y)$ in color image **108** is a vector pixel that may be expressed as follows:

$$C(x, y) = \begin{bmatrix} R(x, y) \\ G(x, y) \\ B(x, y) \end{bmatrix}$$

- where (x, y) are coordinates of an image pixel and C refers to color image **108** and R , G and B are the respective light intensity values for red, green, and blue light. If a cluster S of corresponding pixels in each of the three intensity images have an identical value,
- 20 namely $R(x, y) = G(x, y) = B(x, y)$, then spot S on object **104** is colorless. Spot S would appear as a gray that is visually between dark (0) to white (255). Conversely if a cluster of pixels S' has different color intensity value, i.e. $R(x, y) \neq G(x, y) \neq B(x, y)$, the spot S'

on object **104** would be visually colorful. For example, a pure red, green, or blue pixels are expressed as $C(x, y) = [255 \ 0 \ 0]^T$, $C(x, y) = [0 \ 255 \ 0]^T$, or $C(x, y) = [0 \ 0 \ 255]^T$, respectively. To ensure that object **104** can be exactly reproduced as a color image, the imaging system **200** must be well designed to accurately capture the three different color intensity arrays. The three different color intensity arrays are then combined to reproduce the colors of object **104** in the resultant color image.

A CMOS Image Sensor Array

Figure 2B illustrates a block diagram of a typical prior art two-dimensional Complementary Metal-Oxide Semiconductor (CMOS) image sensor array.

Each element in the array (such as array elements **221**, **222**, and **223**) is an individual CMOS image sensor circuit. The individual CMOS image sensor circuits are also known as pixel circuits. In a gray scale image sensor, each photo sensor captures light without regard to light color.

In a color image sensor array, as illustrated in **Figure 2B**, each of the individual CMOS image sensor circuits may be covered by a selectively transmissive filter. According to one embodiment, there are three selectively transmissive filters, red (R), green (G), and blue (B). Thus, the individual CMOS image sensor circuits superimposed respectively with a red, a green, or a blue filter, are reactive to the red, green or blue light components of the incoming light. Therefore, the image sensor array **204** of **Figure 2B** produces R, G, and B intensity signals. The photo sensors are highly sensitive to light and each produces a proportional electronic signal with respect to the strength of the incident light.

Figure 2C illustrates a more detailed embodiment of a CMOS image sensor array. The CMOS image sensor array of **Figure 2C** is controlled by row decoder

281 and a column decoder **282**. The row decoder **281** and column decoder **282** select a particular CMOS image sensor circuit to be accessed.

The output of an activated CMOS image sensor circuit is carried down a column output line to a sense and hold circuit **283**. The sense and hold circuit **283** senses the voltage value of an activated CMOS image sensor circuit. The sensed voltage value is converted into a digital value by an analog to digital converter **284**. The digital value can be read out of analog to digital converter **284** by an outside unit.

Improved CMOS Image Sensor Device

Figure 3A shows a functional block diagram of an improved image sensor device **300** according to one embodiment of the present invention. As can be seen in **Figure 3A**, the improved image sensor device **300** integrates several functions of a digital imaging system onto a single integrated circuit die.

When the image sensor **300** is used in the imaging system **100** of **Figure 1**, the design complexity of the imaging system **100** can be significantly simplified as illustrated in **Figure 4**. Specifically, when an imaging system is implemented with the improved image sensor device **300**, the imaging system can use the output signals from the improved image sensor device **300** directly. Thus, the improved image sensor device **300** may be coupled directly to a display driver **402** for display on a display screen **472**. A digital signal processor (DSP) **404** may be coupled to the improved image sensor device **300** for performing more sophisticated processing tasks. For example, the digital signal processor (DSP) **404** may perform object extraction and recognition in robotic vision applications, video streaming for Internet video applications, image compression, image manipulation, and other image processing operations.

The Photo Sensor Array

The image sensor device **300** comprises an array of photo sensors **302** superimposed with red, green and blue filters. In one embodiment, the arrangement of R, G, and B photo sensors is conformed to the Bayer arrangement. Furthermore, each
5 column of photo sensors is coupled to a readout column bus **350-1**, **350-2**, ... **350-n** as shown in **Figure 3B**. As such, electronic image signals from an entire row of photo sensors can be readout in parallel. According to one embodiment, the image sensor device **300** has an array of 1024 by 768 photo sensors and hence there are 1024 readout buses. Under clock signals from a timing generator **316**, it takes 768 cycles to serially
10 read out all of the electronic signals in the image sensor **300** after the light integration process.

Photo Sensor Sampling

As a part of an internal auto-calibration process, the outputs of columns of the photo sensors **302** are carried down the readout buses **350**, respectively, to a bank of
15 correlated double sampling circuits (CDS) **308** that sample the signals. In a preferred embodiment, the sampling method of the correlated double sampling circuits (CDS) **308** removes fixed pattern noise from the electronic signals. The fixed pattern noise is unique to CMOS image sensors and considered one of the main disadvantages in comparison with CCD image sensors. In a prior art method, canceling the fixed pattern noise can be
20 performed by off-chip storage of the offset values, obtained by reading the output of the photo sensors while they are reset. That method, however, requires a large amount of memory for storing the entire array of offset information.

The image sensor device **300** uses a correlated double sampling circuit **308** that is an efficient on-chip method. During a readout process, two samples are taken: a

first sample when a photo sensor is in a reset state and a second sample when the electronic signal from the photo sensor has been transferred to the read-out node.

Analog Pixel Processor

After sampling the image sensor device with a correlated double sampling circuit 308, the analog signals can be processed by an analog pixel processor (APP) bank 310. The analog pixel processor can perform many different types of pixel processing in the analog domain. For example, the analog pixel processor (APP) bank 310 may perform edge detection, motion processing, or color balancing.

In one embodiment, one analog pixel processor is shared for every N columns of the photo sensor array. For example, there may be one analog pixel processor for every eight columns from the photo sensor array. In such an embodiment, the analog pixel processor is shared by the eight columns in a time division multiplexing manner. This allows a sophisticated analog pixel processor to be created even when the pixel pitch becomes very narrow.

In one embodiment, the analog pixel processor comprises a programmable gain amplifier for color balancing. Energy from red, green, and blue light is not absorbed equally by the photo sensors in the photo sensor array 302. Thus, the integration values from red, green, and blue photo sensors must be equalized before being used within an image. Prior art imaging systems performed such color equalization in the digital domain with a digital signal processor long after the photo integration values had been read from the image sensor array. However, such systems lost valuable information from the weaker signals. Specifically, the dynamic range of weaker signals is lost since the digitization range must be set to capture the signal with the largest dynamic range.

One embodiment of an image sensor device built according to the teachings of the present invention uses the analog pixel processor to perform analog color balancing to the integration signals from the image sensor before the integration signals are digitized. Specifically, a programmable gain amplifier (PGA) bank amplifies the signals sampled by the correlated double sampling circuits (CDS) **308**. The programmable gain amplifiers can amplify the incoming analog signals with a gain that depends on the measurement from the correlated double sampling circuit **308**. In such a manner, the analog electronic signals are properly adjusted before being digitized in one of the analog-to-digital converters (ADC) **312**.

10 In other words, after an analog integration electronic signal from a photo sensor is read out, the analog integration electronic signal is first measured and then adjusted accordingly before it is sent to an ADC for digitization. This technique results in a maximum dynamic range by allowing complete use of a full input range of the ADC bank **312**. No dynamic range is lost due to offset in any of the three blocks **308**, **310** and
15 **312**. By having a wide programmable gain amplifier gain available, the imaging system can operate in a larger range of available light, allowing the analog-to-digital converter (ADC) bank **312** to utilize all of its resolution for each sample.

In the gain amplifiers of many prior art image sensor arrays, all different pixels are amplified using independent controllable amplifiers for all three pixel colors.
20 In such embodiments, green pixels are amplified with a gain of 1.0 (unity gain), red pixels are amplified with a gain of 0.8 to 1.2, and blue pixels are amplified with a gain of 2.5 to 3.0.

In one embodiment of the programmable gain amplifier (PGA) bank **310**, the programmable gain amplifier amplifies the green pixels with a predetermined fixed

gain value. In one embodiment, the green pixels are amplified with a gain of 1.2. The red and blue pixels are then amplified based upon the amplification gain of the green pixel. In one embodiment, red pixels are amplified with a gain of 1.0 to 1.5 and blue pixels are amplified with a gain of 3.0 to 3.5. Thus, the red and blue amplification values are variable and are normalized to the green value.

It should be noted that each row of pixels from a Bayer pattern photo sensor array will consists of Red and Green pixels or Blue and Green pixels. Thus, the amplification values of every other programmable amplifier in the analog pixel processor **310** may be the same.

10 Analog to Digital Conversion

After the analog pixel processor bank **310** has amplified the analog integration values, an analog-to-digital converter (ADC) bank **312** digitizes the signals. The output of the analog-to-digital converter (ADC) bank **312** is a set of n-bit digital values for each sampled pixel.

15 As with the analog pixel processor bank **310**, the analog-to-digital converter (ADC) bank **312** may be multiplexed. Specifically, there may be only one analog-to-digital converter device for each N columns in the photo sensor array. Ideally, the number of analog-to-digital converter devices should equal the number of analog pixel processors. In this manner, the two units may be organized in a pipeline fashion.

20 By multiplexing the analog pixel processor bank **310** and the analog-to-digital converter (ADC) bank **312**, the architecture becomes very scalable. The architecture is scalable in two different manners. First, the size of the photo-sensor array

can be increased linearly by adding one analog pixel processor and the analog-to-digital converter device for every N columns.

Second, the architecture can be scaled according to finer pitches. For example, if the pixel pitch width decreases from 8 microns to 4 microns, then the multiplexing just needs to be adjusted if the same sized analog pixel processor and analog-to-digital converter device are used. For example, an 8 to 1 multiplexor would be replaced by a 16 to 1 multiplexor. In such a system, the frame rate would decrease unless the clock speed of the analog pixel processor and the analog-to-digital converter device were increased. Furthermore, additional current would need to be supplied to the faster operating analog pixel processor and the analog-to-digital converter device.

Pixel Processor

Resultant digital signals (pixels) from the analog-to-digital converter (ADC) bank **312** are coupled to a pixel processor **314**. The pixel processor **314** may perform various tasks on the pixels as to be described in detail below. Depending on applications, the output of the pixel processor **314** may be static image data for still digital camera applications or a stream of image data for video display.

In a simple embodiment, the pixel processor is a register controlled state machine that comprises set of line buffers, associated arithmetic and logic unit (ALU) circuitry, and the control circuitry. The arithmetic and logic unit (ALU) circuitry is controlled by a set of control registers **320** that determine how the pixel processor **314** operates. Using the digital pixel information in the line buffers and the arithmetic and logic unit (ALU) circuitry, the pixel processor **314** may perform many different arithmetic and logical operations on the pixels. By using several line buffers as a type of memory,

many filtering operations can be performed by logically combining temporally different versions of the same data.

In a more sophisticated version, the pixel may comprise a processor unit that accesses programs in on-chip memory **317**. On-chip memory **317** is primarily loaded with programs that are executed along with the pixel processor **314** to achieve desired results. For example, the output of a sophisticated pixel processor **314** may be in a compressed format such as JPEG (Joint Photographic Experts Group). Alternatively, the pixel processor **314** may perform full or partial compression using MPEG, GIF, or wavelet compression systems.

In the simpler embodiment, the pixel processor **314** may perform just a few of the initial steps of a compression system. For example, the line buffer system may process eight adjacent pixels for performing the early steps of JPEG compression. An image processor (a microprocessor or Digital Signal Processor) is thus given a “head start” on the JPEG processing. The detailed description of the processing by the pixel processor **314** in conjunction with the programs in memory **317** will be provided below.

The pixel processor is programmable such that the processing performed by the pixel processor **314** will vary depending on the particular application. In one embodiment, the pixel processor **314** may be controlled using a set of control registers **320**. The control registers may store codes defining the processing to be performed and processing parameters.

The pixel processor **314** is comprised, in part, of a number of pixel data rows **321**. The pixel data rows **321** contain pixel data that has been read out from the photo sensor array **301**. The pixel processor **314** can combined the various pixel data

rows **321** arithmetically and logically. The number of pixel data rows **321** within a particular pixel processor **314** embodiment will be based upon the pixel processing operations that need to be performed.

The improved CMOS image sensor device **300** includes a timing generator **316** that generates the clock signals and other timing references needed by the remainder of the improved CMOS image sensor device **500**. To orchestrate the operation of all the different subsystems in the improved CMOS image sensor circuit **300**, the improved CMOS image sensor circuit **300** includes control logic **218**.

The image data from the pixel processor **314** may be directly streamed out of the pixel processor **314** into another device. In a different embodiment, the output digital signals from the pixel processor **314** are passed to an input/out (I/O) interface **318**. The input/out (I/O) interface **318** facilitates the transmission of the digital signals out of the image sensor device **300** to an external part that may be a digital signal processor or a display driver. In either case, the control registers **320** can be programmed to determine how the pixel processor **314** or I/O interface **318** output the data. Specifically, the pixel processor **314** or I/O interface **318** may perform sub-sampling by outputting only a portion of the available data. According to one embodiment, the pixel processor **314**, memory **317** and I/O interface **318** are monolithically integrated with the array of photo sensors **302**.

Window Gating

Image processing is often done on small areas of a larger overall image array. For example, an auto-focus routine is often performed only used the central “focus area” of an image. Furthermore, a small area of an image containing white pixels may be

used to perform "white balancing" in a video camera application. To help indicate the data for such routines is being output, the present invention introduces "window gating". Window gating is used to identify a defined subset of pixels from a larger pixel area. Two different window-gating systems are introduced: random access window gating and serial highlighted window gating

Random Access Window Gating

Unlike Charge Coupled Device (CCD) image sensors in which electronic signals generated after the light integration must be all sequentially readout, the dynamic access provided by the CMOS image sensor device **300** of the present invention permits selective readout. In other words, signals in a particular area of photo sensors can be read out without reading out all the signals in the sensor. This feature is important to a number of applications that demand high signal throughput when the spatial resolution of the image sensor is increased. For example, it would take a considerable time to readout all 786,432 pixel signals from an image sensor having 1024 by 768 photo sensors thereon while not all of the signals are necessary for determining exposure time and digital zoom.

Referring again to **Figure 3A**, there is a pair of column address decoder **304** and row address decoder **306** in the image sensor device **300**. With the column address decoder **304** and the row address decoder **306**, each of the photo sensors **302** can be selectively accessed. One of the features in the present invention is to utilize the column address decoder **304** and row address decoder **306** to provide an effective readout from the image sensor for auto focus, color balance and exposure control.

Referring to **Figure 5A**, there is an image sensor **500** having 1024 by 768 photo sensors thereon and each of the photo sensors is addressed by a pair of column address decoder and row address decoder. A subarea or region of interest (ROI) **502** is

defined by parameters that are dependent on the applications. For example, for an auto focus application the region of interest (ROI) **502** is typically small (100 by 100 or 200 by 200) and centered in the image sensor array **500**. Therefore, the column address decoder produces column address signals identifying the photo sensors located on columns from 462 to 561 and the row address decoder produces row address signals identifying the photo sensors located on rows from 334 to 433. The column address signals **504** and the row address signals **506** illustrate that region of interest (ROI) **502** is being defined and only the electronic signals in ROI **502** will be readout. It should be noted that the entire array of image sensor array **500** functions in the light integration process. Hence, every photo sensor in the image sensor array **500** has collected charges. However, only the electronic signals in the photo sensors within the defined window gating signals, namely the column address signals **504** and the row address signals **506**, are readout. Consequently, the readout process after the light integration process is much faster.

Highlighted Serial Window Gating

Another method of identifying a desired pixel subarea is to use highlighted serial window gating. Highlighted serial window gating operates by signaling when pixels from the desired subarea are being output when an entire pixel array is output. For example, referring to **Figure 5A** a pixel array **500** is illustrated. Within the pixel array **500**, a smaller desired subarea **502** to be processed is identified with by a rectangle. In one embodiment of the present invention, the subarea **1010** is identified by a first row, a number of rows, a first column, and a number of columns. These parameters can be entered into control registers **320** that control the pixel processor **314** of the present invention.

To inform another circuit coupled to the photo sensor device **300** as to when the pixels in the identified subarea **502** are being output, the present invention uses

a window gate signal. The window gate signal is normally inactive. Thus, when the first set of rows of pixel array **500** are scanned, the window gate signal remains inactive as illustrated by the window gate signals **551**. However, when the improved photo sensor device **300** of the present invention is scanning out pixels that are within the identified subarea **502**, the window gate signal is driven active as illustrated by window gate signals **553**. After the photo sensor device **300** has scanned past the pixels of the identified subarea **502**, the window gate signal is inactive as illustrated by window gate signals **555**.

Using the window gate signal, an area in the center of the image array can be set as the subarea to be identified in a digital camera application. Then, when the autofocus routine needs to be performed, the pixels in the focus area will be identified to a digital signal processor using the windows gate signal.

It is noted that the window gating signals do not have to define a region of interest (ROI) in the center of the image sensor. Furthermore, there can be one or more region of interest (ROI) in the image sensor depending on a specific application.

Figure 6A illustrates a flowchart to illustrate the process for reading out electronic signals from a region of interest (ROI) for auto focus, digital zoom and other similar applications. At block **602**, before the light integration process, the image sensor device needs a number of parameters to set it up for proper operations. Examples of the parameters include initial electronic shutter speed, initial exposure time, and initial white balance. It is assumed the imaging system is powered on and triggered to start the light integration process. With the parameters, particularly the boundary parameters for one or more region of interest (ROI), loaded at block **604**, the image sensor integrates incident light for a defined time to produce an image of a target at block **606**. Since the captured image data is for the determining if the imaging system has been properly adjusted, only a

small portion image data in the center area of the image sensor is needed. At block **608**, the window gating signals are determined with respect to the boundary parameters. In a random access system, the window gating signals cause the column and row address signals to address only the desired portion of the array. In a highlighted serial window gating system, the window-gating signal is active when the desired region is scanned. At block **610**, signals only in a small portion of the center area of the image sensor addressed by the column and row address signals are readout to column buses. It should be noted that the order of blocks **606** and **608** are interchangeable. As illustrated in **Figure 6A**, if there are no boundary parameters loaded at block **602**, all signals in the image sensor will be readout at block **610**.

At block **612**, the readout signals are processed by the CDS bank and the PGA bank to produce a set of optimal image signals. At step **614**, the ADC unit digitizes the analog signals to produce a set of digital signals that represent the area or areas defined by the boundary parameters. The set of digital signals is then processed in the pixel processor at block **616**. Depending on the actual use of the set of digital signals, the pixel processor is configured to produce appropriate outputs.

According to one embodiment, one output from the pixel processor is for an auto focus feature. The pixel processor executes a set of instructions to determine if the incoming set of digital signals possesses sharp edges. **Figure 6B** illustrates an exemplary approach based on derivative calculations for the pixel processor to cause the imaging system to focus on the target consequently to produce in-focus images. It is assumed that the readout signals represent an image **630** of two contrast areas, thereby there is an edge between the two contrast areas. If the imaging system is out of focus, a single row signal **632** across the two regions tends to be monotonic and the pixel

processor can detect from the corresponding derivative signal **633** that the imaging system was out of focus and the output is forwarded to block **604** of **Figure 6A** to repeat blocks **606**, **608**, **610**, **612** and **616** with a new setting for the focus.

Another set of digital signals are then generated under the new setting for the focus, one of the signals is represented by a row signal **634**. This time the row signal **634** possesses certain discontinuity caused by the edge between the two contrast areas. The output of the pixel processor based on the corresponding derivative signal **635** causes the imaging system to further adjust the focus thereof and is forwarded to block **604** to start blocks **606**, **608**, **610**, **612** and **616** with another new setting for the focus.

Another set of digital signals is generated, one of which is represented by a row signal **636**. The pixel processor can detect from the corresponding derivative signal that the imaging system is now in focus as the corresponding derivative signal possesses a sharp pulse resulting from a sharp edge. It is clear from the context that the focusing processing can be repeated until a determination passes a threshold. The output of the pixel processor may be set to cause a generation of an audible sound so that a user of the system is notified of the status and proceeds to capture images of the target. When it is ensured that the imaging system is in focus of the target, the image sensor is ready to produce a full image of the target.

In a digital camera, the pre-focus process may be triggered by a half-activation of the shuttle button. In a video camera, the pre-focus process may be automatically started when a user presses a "On" or "record" button and before the sensor produces sequence of images. In either application, the auto focus process must be fast enough that the user experiences virtually no latency in capturing a desired target. Those

skilled in the art will appreciate that a fast speed is achieved by selectively reading out a small subarea of the full image sensor array and processing just that small area.

It should be pointed that the example in **Figure 6B** is for illustration only.

Many other approaches may be used by the pixel processor for auto focus application.

- 5 The important feature of the present invention is the high signal throughput, hence considerable high speed for those applications that require a small set of image data. Reading a full set of image data from the image sensor requires a lengthy time that may cause jitter feeling to the user.

Pixel Interpolation

- 10 Digital zoom is an application that uses a small set of signals from an image sensor array but displays that small set of signals as a full image. **Figure 7A** illustrates an image of a house captured by an image sensor **702**. However, the user is interested in viewing the front window portion. A mechanism is provided for the user to move a window **704** over the region of interest (ROI). The size of the window **704** is
- 15 adjustable by the user to enclose the entire region (a front window of the house) as shown in **Figure 7A**. After an activation of a trigger, only signals corresponding to the ROI are readout and then processed in the pixel processor. The ROI is then properly displayed on a screen **706** in which only the front window of the house is displayed as illustrated in **Figure 7A**.

- 20 **Figure 7B** shows the process flowchart according to one embodiment of the present invention. At step **710**, the image sensor is ready for the light integration process but waits for a triggering signal that may come from a shutter release of a digital camera or "On" button from a video camera. Upon being triggered, the image sensor

starts the light integration process at block **712**, accumulating photons of incident light for a predefined exposure time. To view the captured image, the signals in the image sensor are read out in an appropriate manner for a display for preview at step **714**. A preview display is typically small and low resolution. For example, a typical pre-view screen may
5 be two or three inches along its diagonal with a resolution of 70 dots-per-inch (DPI). A decimation process, as explained below, selectively reads out a limited number of pixels for display on the preview display.

At step **716**, the user defines a window by moving and adjusting the window around a region of interest (ROI), which inherently defines the boundary
10 parameters and thus the window gating signals. As soon as the user is done with the region of interest, the signals in the photo sensor array corresponding to the region of interest are readout at step **718** with respect to the window gating signals. At step **720**, the readout signals are processed by the CDS bank and the PGA bank. At step **722**, the ADC bank digitizes the analog signals to produce a set of digital signals representing the
15 region of interest defined by the boundary parameters.

The set of digital signals is then processed in the pixel processor at step **724**. An interpolation methodology is implemented in the pixel processor to expand the limited pixel data. According to one embodiment, a neighbor linear interpolation approach is used. Specifically, a “missing” pixel is created by interpolating from its
20 neighbor pixels. Those skilled in the art understand that there are other interpolating methods that may be implemented in the pixel processor.

Figure 7C conceptually illustrates an example of a small portion of signals **754** from the image sensor array being enlarged by the interpolation process. After the image **750** is displayed, the user defines the region of interest by moving and

adjusting the window 752 to surround it. The addresses identifying the corresponding photo sensors 754 on the image sensor array are inherently determined and the signals thereof are correspondingly read out. The digital version of the signals is subsequently processed in the pixel processor for interpolation. In this example, an interpolated image 256 has spatial resolution 4 times as large as the original corresponding photo sensors 754. Specifically the whites dots are interpolated from the neighboring image pixels (directly from the photo sensors).

Pixel Decimation

Pixel decimation is a process that samples the signals from the photo sensors for low resolution needs. For example, not all the pixel signals from the image sensor are needed for a preview image on a small screen. Specifically, a small preview display screen located on digital camera system can only display a limited amount of data. Thus, it would be desirable to incorporate systems for reducing the amount of data that is output from the image sensor device in certain situations.

Photo Sensor Skipping Pixel Decimation

One method of reducing the amount of data that is output is to skip certain photo sensors during read out. According to one embodiment of the present invention, both the column and row decoders are configured to cause signals to be read out from every other photo sensors. Other repeated patterns (such as every third or every fourth photo sensor) can also be read out from the photo sensor array.

Figure 8A illustrates an embodiment wherein the signals from an array of photo sensors 800 are being decimated by a factor of two. Through a set of predefined parameters, both column and row decoders produce, respectively column and row address

signals **802** and **804**. In other words, column and row address signals **802** and **804** identify which signals from the array of photo sensors **800** are read out. As illustrated in **Figure 8A**, column and row address signals **802** and **804** cause signals from every other photo sensor to be read out to column buses **806**.

5 **Figure 8B** illustrates a conceptual diagram wherein only every other row and column from array **850** is activated during read out to produce a low-resolution pixel image **860**. Numerically, the spatial resolution of the digital version **860** is one quarter of that of the array of photo sensors **850**. Similarly, the readout speed is also improved four times. Those skilled understand that the decimation process is not possible in CCD
10 image sensor in which all signals must be sequentially shifted out and subsequently stored in a large memory for decimation.

One very important use for pixel decimation is digital camera parameter adjustment. As set forth in the previous section, window gating allows a small subarea to be used for auto focusing. Similarly, pixel decimation can be used to read out low
15 resolution images that sample that may be used to set the image capture parameters for a digital camera. In one embodiment, the camera's control system captures a decimated image that provides low-resolution pixel information from the entire pixel array area. The low-resolution image information is processed to determine the image quality. Based upon the -resolution image information, the camera's control system may adjust various
20 camera parameters to improve the image quality. For example, the camera control system may adjust the white balance, the programmable gain amplifiers (PGA), the exposure time, the iris opening size, and/or other camera parameters in order to improve the quality of the final image to be captured. By decimating the image before processing, the camera control system has less data that must be processed for each parameter adjustment

iteration. By reducing the time per adjustment iteration, more iterations of parameter adjustment can be performed in the same amount of time. Thus, the camera control system can perform adjustments very quickly such that virtually no latency period exists between when the user points the camera and when the user can capture an image.

5 Pixel Averaging Decimation

Another method of performing pixel decimation is to combine neighboring pixels into a single pixel. For example, referring back to **Figure 8B**, the pixel processor can combine the four pixels in box **851** by averaging the pixel values to produce a single pixel output **861**. The pixel averaging operation is similar to interpolation. However, 10 unlike interpolation, the data from the original rows is then discarded. This example would be pixel averaging decimation by 1/4 since one pixel would be output for every four input pixels. Decimation can be performed up to 1/N since there are N rows in the pixel processor. Thus, if there were eight rows in the pixel processor, 1/8 pixel averaging decimation could be performed.

15 **Pixel Co-Siting**

Pixel Co-siting is a process that combines information from neighbor pixels to create a single pixel. Pixel Co-siting is a type of pixel interpolation that creates the same number of output pixels as there are input photo sensors. Pixel co-siting cures some image artifacts by smoothing the image. **Figure 9A** conceptually illustrates a small 20 section of a Bayer pattern pixel array. The first row consists of alternating Red (R) and Green (G) pixels. The second row consists of alternating Green (G) and Blue (B) pixels. The remaining rows follow this pattern of alternating Red (R) and Green (G) pixel rows and alternating Green (G) and Blue (B) pixel rows.

If the first row were to be read out individually, it would not have any blue pixel data. Similarly, if the second row were to be read out individually, it would not have any blue pixel data. Instead, the pixels are "co-sited" wherein adjacent row and column data are combined form a single pixel.

For example, referring to **Figure 9A**, the top two rows of the two leftmost columns are combined to form a single pixel. Specifically, the photo sensors in box **904** are combined to create pixel **905**. Note that the pixel processor may average the value of the two green pixels within box **904**. An adjacent pixel would be formed from the top two rows of the second and third columns. Specifically, the photo sensors in box **908** are combined to create pixel **909**. In this manner, every pixel will be given Red, Green, and Blue pixel values. Although this example performs pixel co-siting with four photo sensors, pixel co-siting can be performed with other numbers of pixels. For example, **Figure 9B** illustrates a pixel co-siting example with nine neighboring pixels.

Additional Features in Pixel Processor

To reduce the design complexity and to increase the performance of an imaging system employing the current CMOS image sensor, additional features may be implemented in the pixel processor.

In a digital camera, the common image formats of the output are preferably the Graphic Interchange Format (GIF) and the Graphic Interchange Format (GIF). In video, the common image formats of sequence of images include MPEG (Moving Picture Experts Group) and some emerging standards for video stream. All of these image formats are supported by the World Wide Web protocol, such as HTTP. Conventionally,

the format transformation from the pixel signals to one of the commonly used formats is carried out in a separate processor in the imaging system (e.g. the digital or video camera). For example, many imaging systems use a desktop personal computer along with an appropriate compression program. Such existing approaches present either
5 considerable latency that may be experienced by a user or a complicated configuration.

According to one embodiment, the image sensor **300** has 1024 by 768 photo sensors that could produce 786,431 pixel charge signals. When the charge signals are digitized to the 10-bit precision, there would be nearly one megabyte of image data. Together with a sequence of images for video applications, the amount of data would be
10 too big to be used and must be compressed before an apparatus coupled thereto can accommodate them.

As described above, the on-chip memory **317** of **Figure 3A** may be loaded with instructions (microcode) that perform a pixel processing application. In one embodiment, a pixel processor program is executed in the pixel processor **318** to perform an image
15 format transformation such that the output of the image sensor device **300** is in conformation with an image standard. The exact implementation of a compression program is not provided herein to avoid obscuring aspects of the present invention. Those skilled in the art appreciate that such microcode is available for general-purpose digital signal processors (DSP). The important feature of compressing pixel signals
20 within an image sensor, contrary to those general-purpose DSPs, is that there are no additional memory needed to pre-store the pixel signals. The pixel signals from the ADC bank are compressed as they are coming. As a result, the overall signal throughput of the imaging system is not degraded due to the compression procedure in addition to the elimination of a large memory.

Furthermore, the pixel processor may be configured to output only black and white pixel signals. Referring to **Figure 10**, pixel signals **1002** from the R, G, and B photo sensors in the array of photo sensors are in a color format. Thus, signals from each group of the R, G, and B photo sensors compose a red, green, or blue color pixel, respectively. There several ways to internally convert the signals from the R, G, and B photo sensors to gray-scale intensity signals.

One of the methods is to apply different weights to the different components; for example, $0.299R$, $0.587G$ and $0.114B$. The sum of the weighted color components result in a gray-scale intensity value.

Another way as illustrated in **Figure 10**, a group of four signals from a geometric group **1004** of the photo sensors are averaged to produce a gray-scale intensity value **1006**. Therefore, the pixel signals are decimated by a factor of two while being converted to gray-scale intensity signals. Alternatively, each signal from a photo sensor **1008** or **1010** is weighted differently and directly output as a gray-scale intensity **1012** and **1014** to preserve the original spatial resolution.

Another way is to simply output the values from the green photo sensors in Bayer pattern array. This method works well since the green sensor captures the most light and the human eye is most tuned to green light.

The present invention has been described in sufficient detail with a certain degree of particularity. It is understood to those skilled in the art that the present disclosure of embodiments has been made by way of examples only. Numerous changes in the arrangement and combination of parts may be made without departing from the spirit and scope of the invention as claimed. Accordingly, the scope of the present

invention is defined by the appended claims rather than the forgoing description of embodiments.

03588.P002X

CLAIMS

We claim:

- 1 1. A method for facilitating high signal throughput of an improved CMOS image sensor
2 comprising a plurality of photo sensors configured in a two-dimensional array; said
3 method comprising:
4 generating column address signals and row address signals that address a subset of
5 said two-dimensional array according to a set of parameters; and
6 reading out charge signals from a set of the plurality of photo sensors in said
7 image sensor; said set of photo sensors addressed by said column address
8 signals and said row address signals.
- 1 2. The method as recited in claim 1 wherein said reading out charge signals comprises:
2 shifting said charge signals from said set of the plurality of photo sensors,
3 respectively, to line buses in parallel;
- 1 3. The method as recited in claim 2 further comprising:
2 conditioning said charge signals to appropriate levels before being digitized in
3 parallel in a bank of analog-to-digital converters to produce pixel signals; and
4 processing said pixel signals with respect to instructions from a memory;
- 1 4. The method as recited in claim 3 wherein said processing said pixel signals is carried
2 out in a pixel processor.

1 5. The method as recited in claim 4 wherein said pixel processor and said memory are
2 monolithically integrated with said plurality of photo sensors of the CMOS image
3 sensor.

1 6. The method as recited in claim 3 wherein said conditioning said charge signals
2 comprises balancing colors in said charge signals.

1 7. The method as recited in claim 6 wherein said balancing colors comprises:
2 deriving a measurement difference of each of said charge signals with a reference;
3 and
4 adjusting said each of said charge signals with respect to said measurement
5 difference.

1 8. The method as recited in claim 2 further comprising generating an optimum exposure
2 time.

1 9. The method as recited in claim 8 wherein said generating an optimum exposure time
2 comprises:
3 deriving a measurement difference of each of said charge signals with a reference;
4 and

5 calculating said optimum exposure time from said measurement difference.

1 10. The method as recited in claim 1, wherein said set of parameters includes coordinates
2 of a region of interest and wherein said generating column signals and row signals
3 comprises:

4 identifying said set of the plurality of photo sensors corresponding to said
5 coordinates of said region of interest;

1 11. The method as recited in claim 10 wherein said processing pixel signals comprises
2 producing a larger set of digital signals by interpolating said pixel signals.

1 12. The method as recited in claim 10 wherein said processing pixel signals comprises:
2 detecting if said charge signals represent an image of a target being focused; and
3 producing a reference signal to cause said image sensor to regenerate said charge
4 signals with a new setting if said detecting indicates said target is not
5 represented well in said image.

3 processor comprises compressing said pixel signals according to a commonly used
4 compression standard.

1 17. The method as recited in claim 16 wherein the commonly used compression standard
2 is selected from a group consisting of Graphic Interchange Format (GIF), JPEG (Joint
3 Photographic Experts Group) and MPEG (Moving Picture Experts Group) supported
4 by a World Wide Web protocol.

1 18. The method as recited in claim 13 wherein said desired result is a gray-scale intensity
2 image and wherein said processing said pixel signals in a pixel processor comprises
3 converting said pixel signals respectively to intensity data according to a predefined
4 conversion standard.

1 19. An architecture for facilitating high signal throughput of an improved CMOS image
2 sensor comprising a plurality of photo sensors configured in a two-dimensional area;
3 said architecture comprising:
4 a pair of column address and row address decoders providing address signals to
5 address each of the plurality of photo sensors;
6 a number of signal conditioning circuits, each coupled to a column data bus
7 receiving charge signals readout from said photo sensors when said photo
8 sensors are addressed by said address signals;

9 a number of analog-to-digital converters, each respectively coupled to one of said
10 conditioning circuits and digitizing said charge signals in parallel; to produce
11 pixel signals; and
12 a pixel processor receiving said pixel signals from said analog-to-digital
13 converters, wherein said pixel signals are processed to produce a desired
14 result.

1 20. The architecture as recited in claim 19 wherein each of the signal conditioning circuits
2 comprises a correlated double sampling circuit and a programmer gain amplifier.

1 21. The architecture as recited in claim 20 wherein said correlated double sampling
2 circuit derives a measurement difference of each of said charge signals with a
3 reference.

1 22. The architecture as recited in claim 21 wherein said programmer gain amplifier
2 receives said measurement difference and adjusts said each of said charge signals with
3 respect to said measurement difference.

1 23. The architecture as recited in claim 21 wherein each of the signal conditioning circuits
2 produces a signal that indicates an optimum exposure time.

1 24. The architecture as recited in claim 23 wherein said correlated double sampling
2 circuit and said programmer gain amplifier together derives a measurement difference
3 of each of said charge signals with a reference; and calculates said optimum exposure
4 time from said measurement difference.

1 25. The architecture as recited in claim 20 further comprises a memory storing
2 instructions; said memory coupled to said pixel processor that executes said
3 instructions from said memory to achieve said desired result.

1 26. The architecture as recited in claim 25 wherein said instructions causes said pixel
2 processor to compress said pixel signals according to a commonly used compression
3 standard.

1 27. The architecture as recited in claim 26 wherein the commonly used compression
2 standard is selected from a group consisting of Graphic Interchange Format (GIF),
3 JPEG (Joint Photographic Experts Group) and MPEG (Moving Picture Experts
4 Group) supported by a World Wide Web protocol.

1 28. The architecture as recited in claim 25 wherein said instructions causes said pixel
2 processor to convert said pixel signals respectively to intensity data according to a
3 predefined conversion standard.

1 29. The architecture as recited in claim 19 wherein said pixel processor is monolithically
2 integrated with said photo sensors.

1 30. The architecture as recited in claim 20 wherein said pixel processor, said correlated
2 double sampling circuit and said programmer gain amplifier are is monolithically
3 integrated with said photo sensors.

Method and Architecture for an Improved CMOS Color Image Sensor

Abstract

According to the principles of this invention, an improved CMOS image sensor is disclosed. The improved CMOS image sensor comprises a pair of controllable column and row decoders, a signal conditioning circuit and a pixel processor in addition to an array of photo sensors. With the pair of controllable column and row decoders, photo sensors can selectively and dynamically accessed to improve signal throughput for applications that do not require the full set of signals from the array of photo sensors. The digitized signals from the selected photo sensors can be processed in the pixel processor for auto focus, pixel signals decimation and interpolation, data conversation and compression. Consequently, the design complexity of an overall imaging system using the disclosed CMOS image sensor is considerably reduced and the performance thereof is substantially increased.

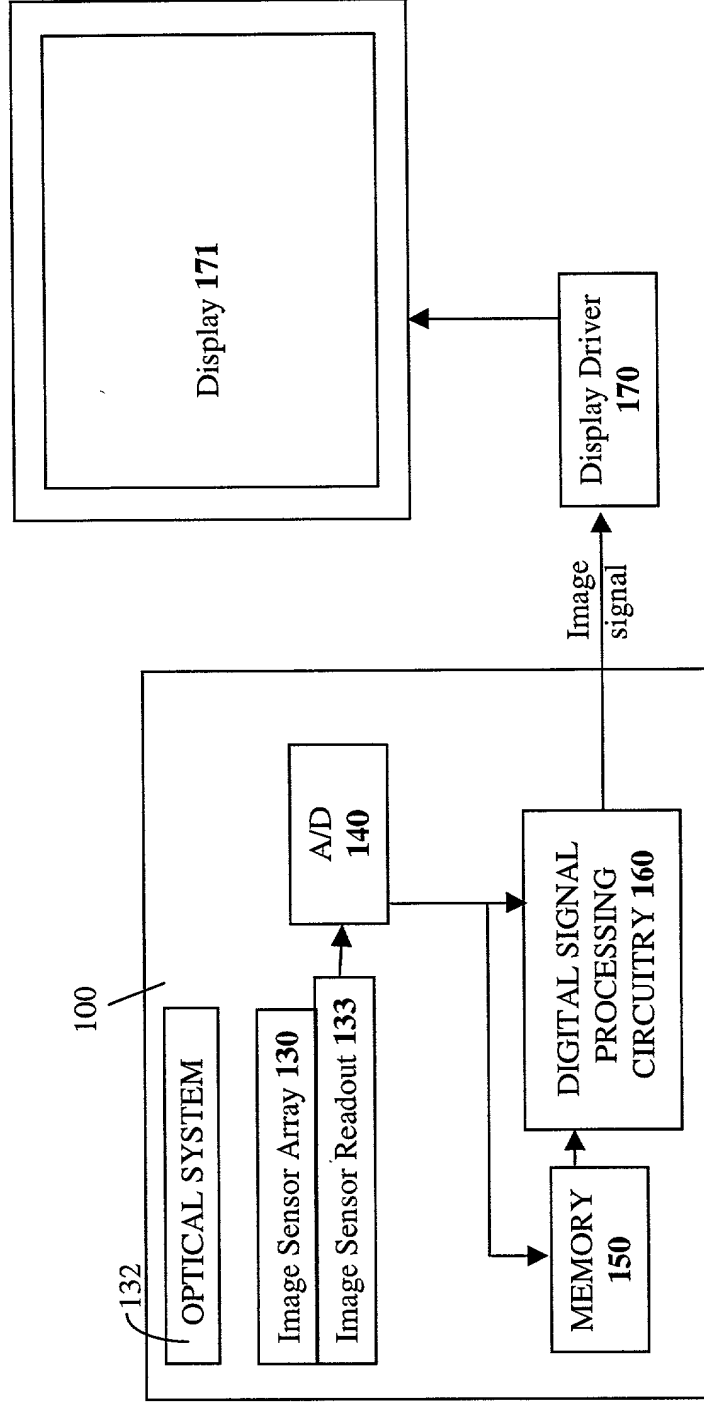


Fig. 1

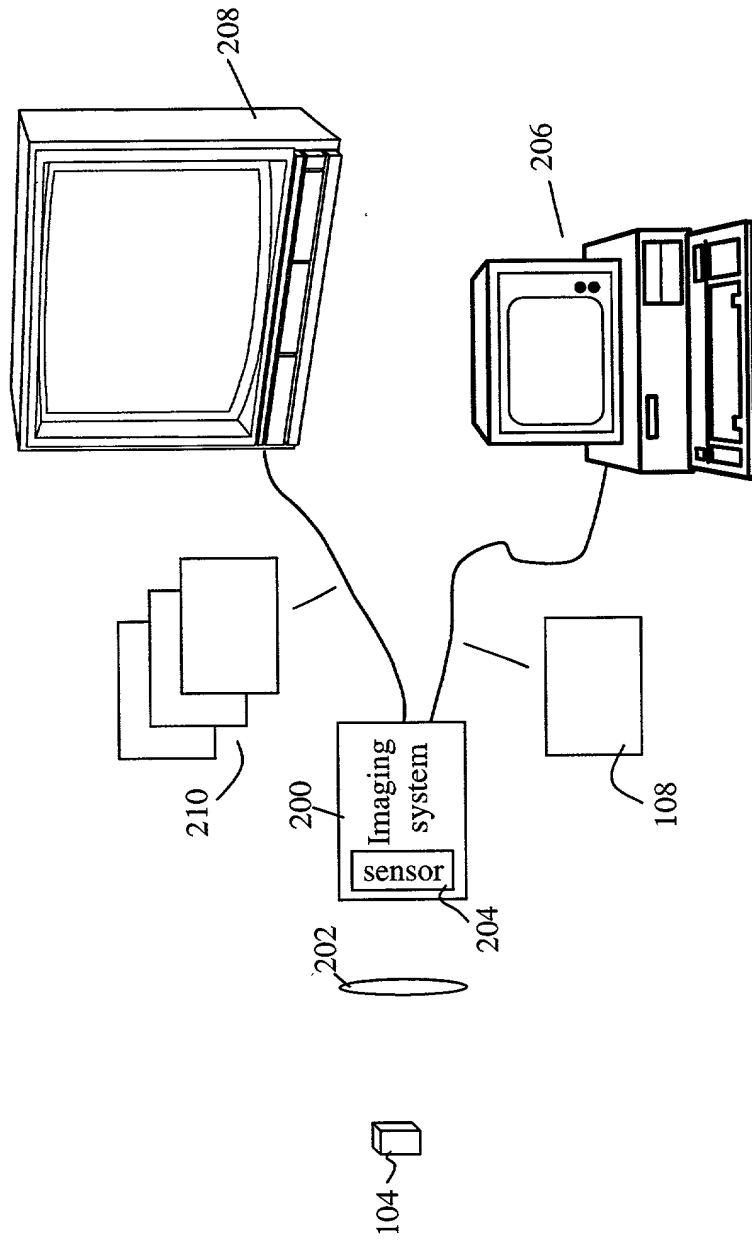


Fig. 2A

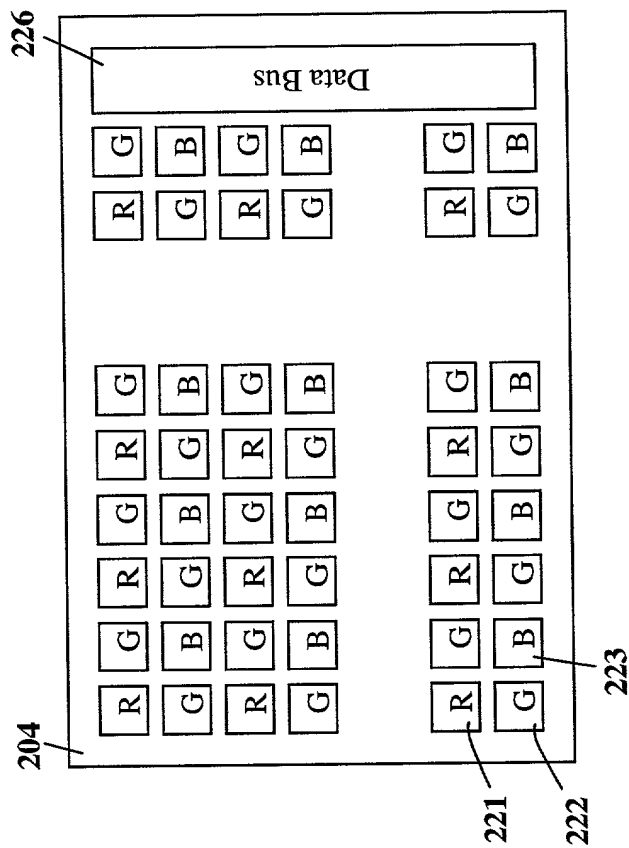


Fig. 2B

Fig. 2C

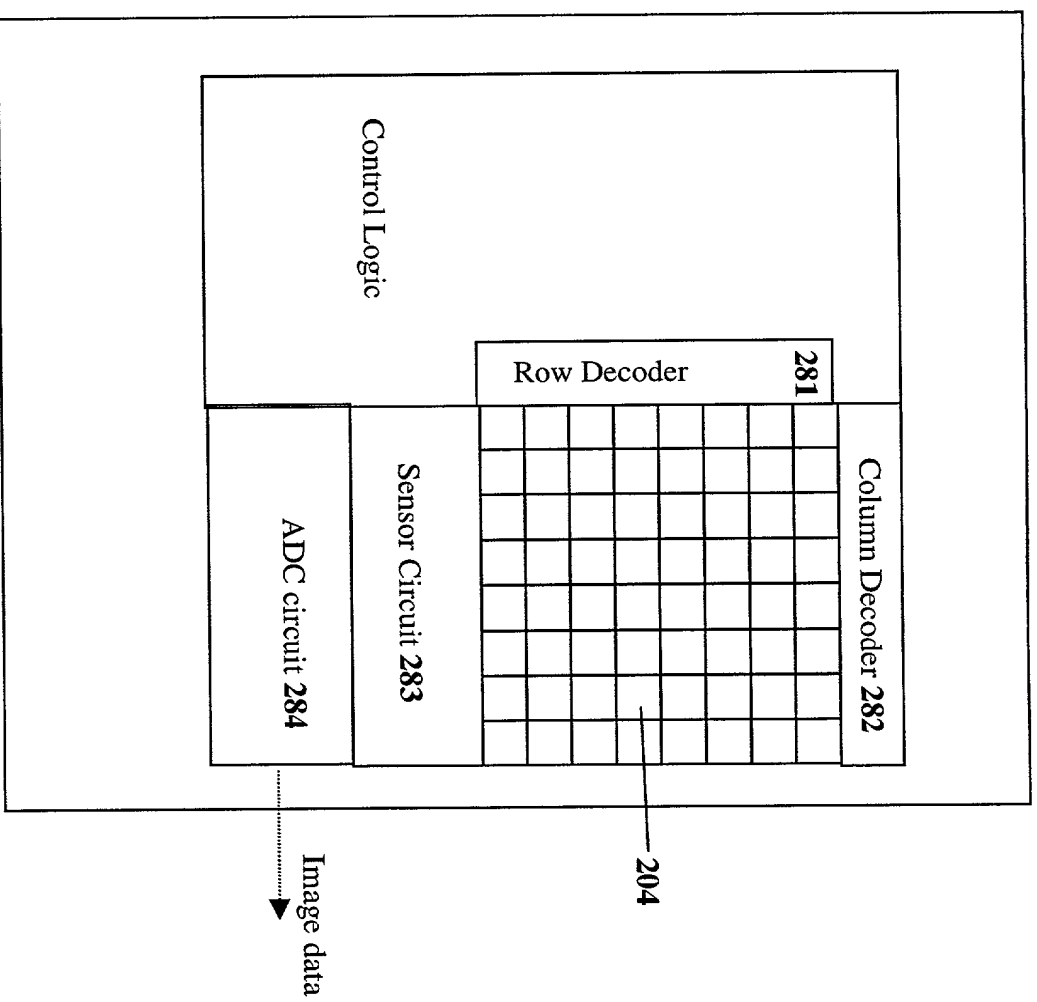
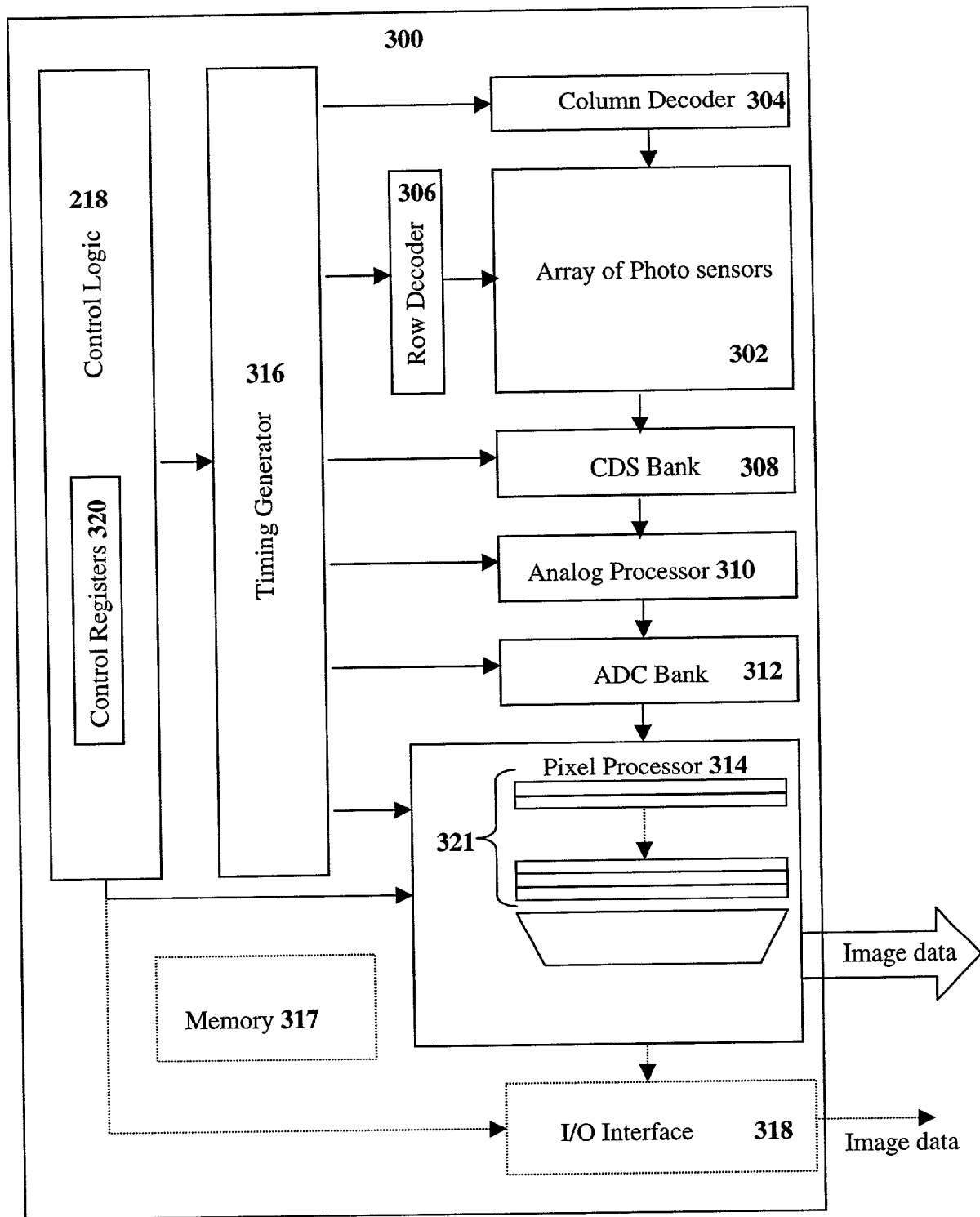


Fig. 3A



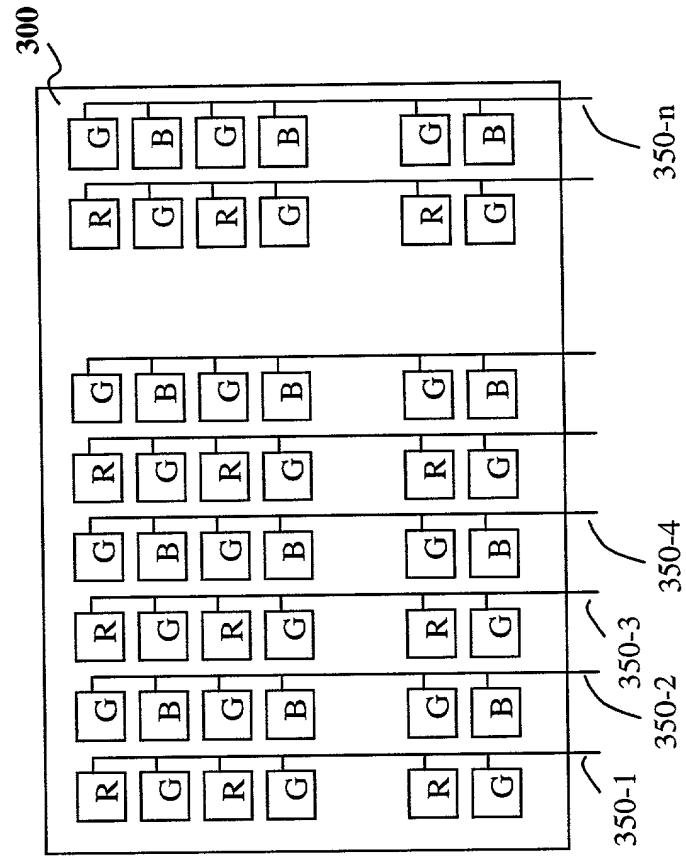


Fig. 3B

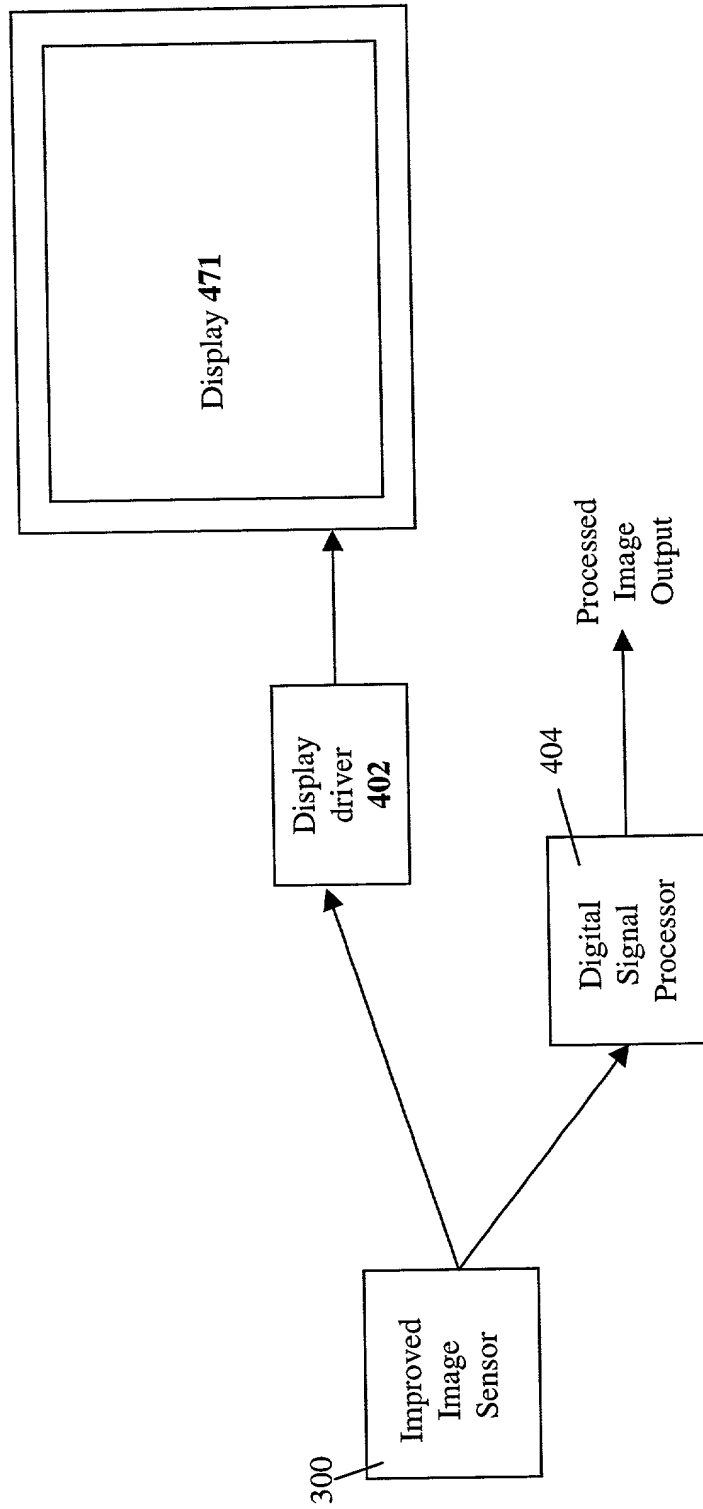


Fig. 4

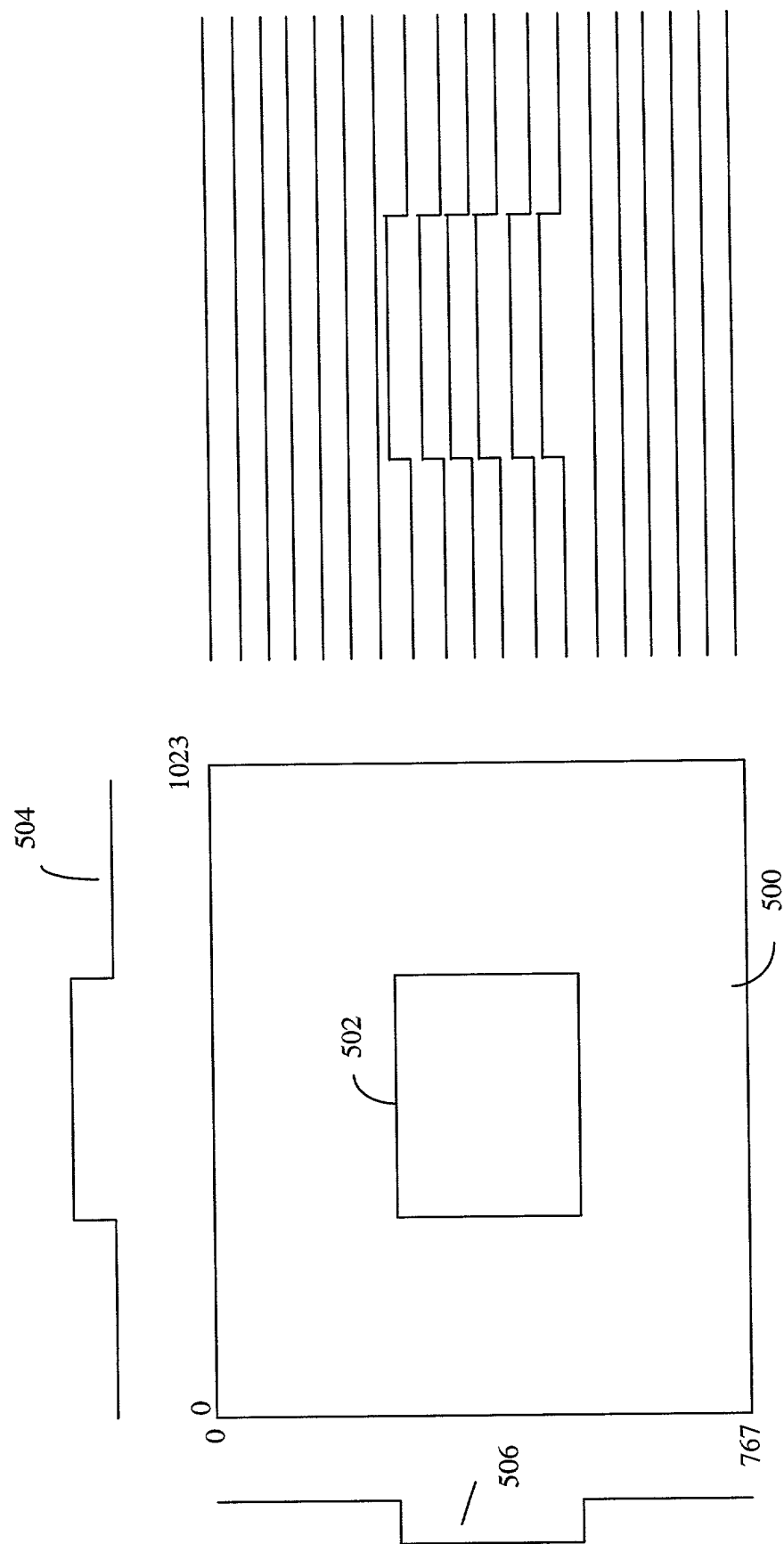
[illegible]

Fig. 5A

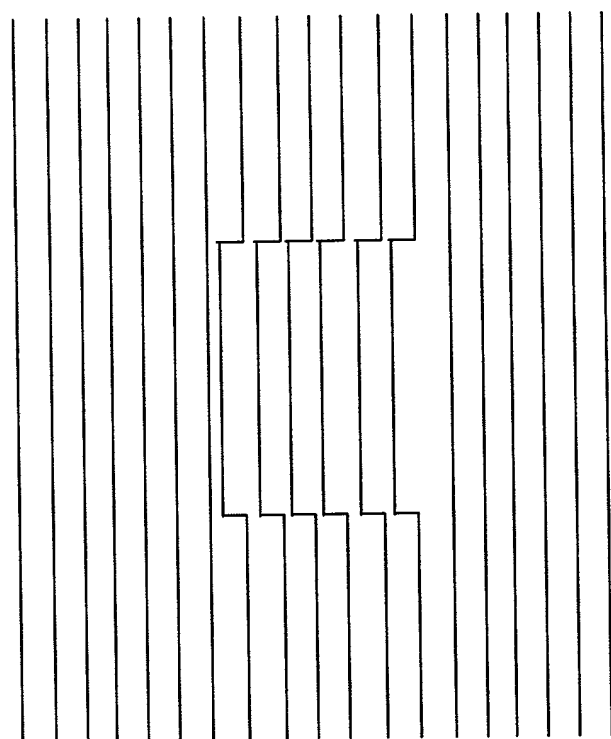


Fig. 5B

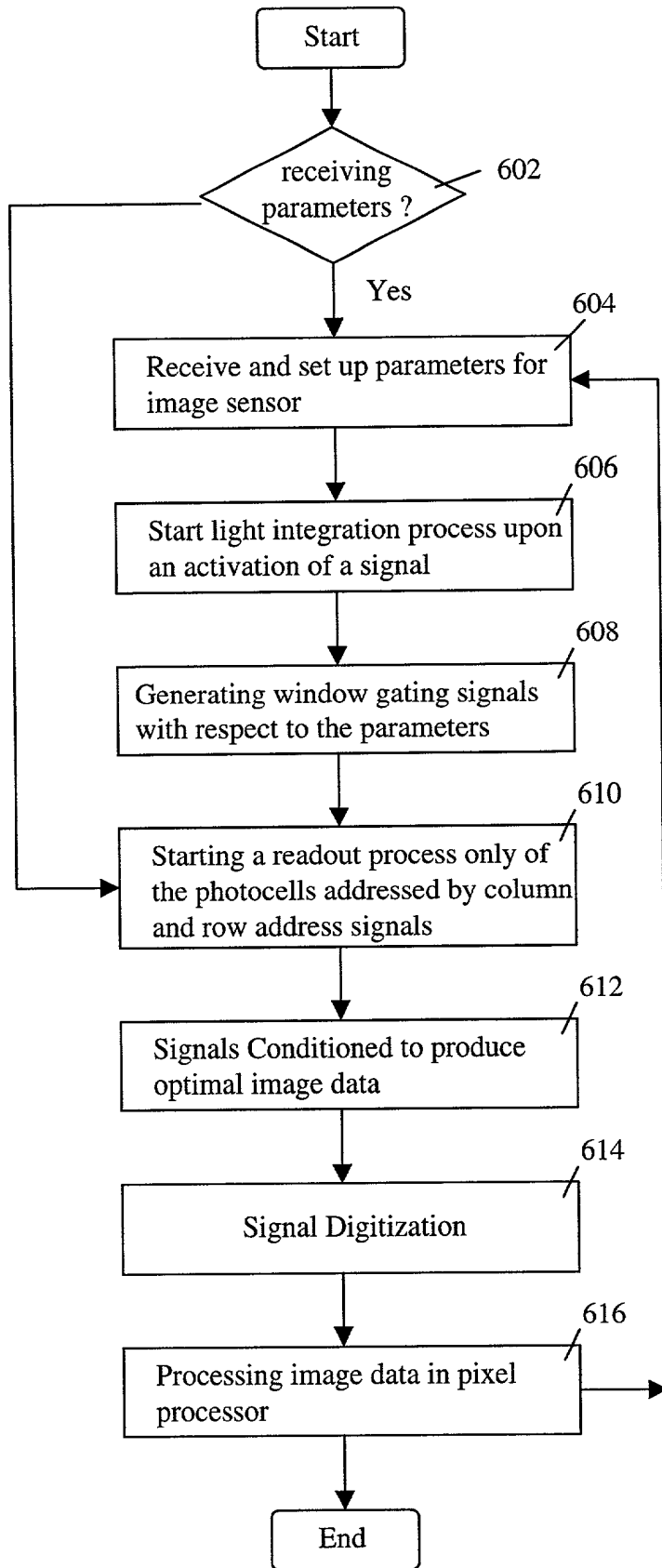


Fig. 6A

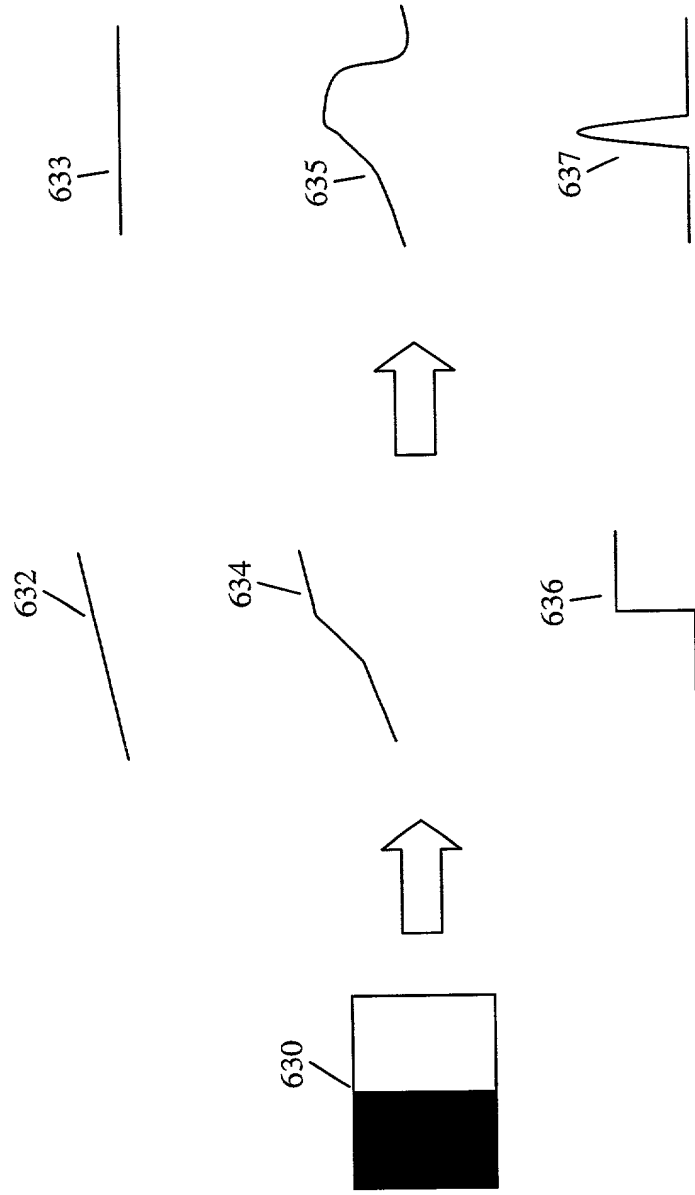


Fig. 6B

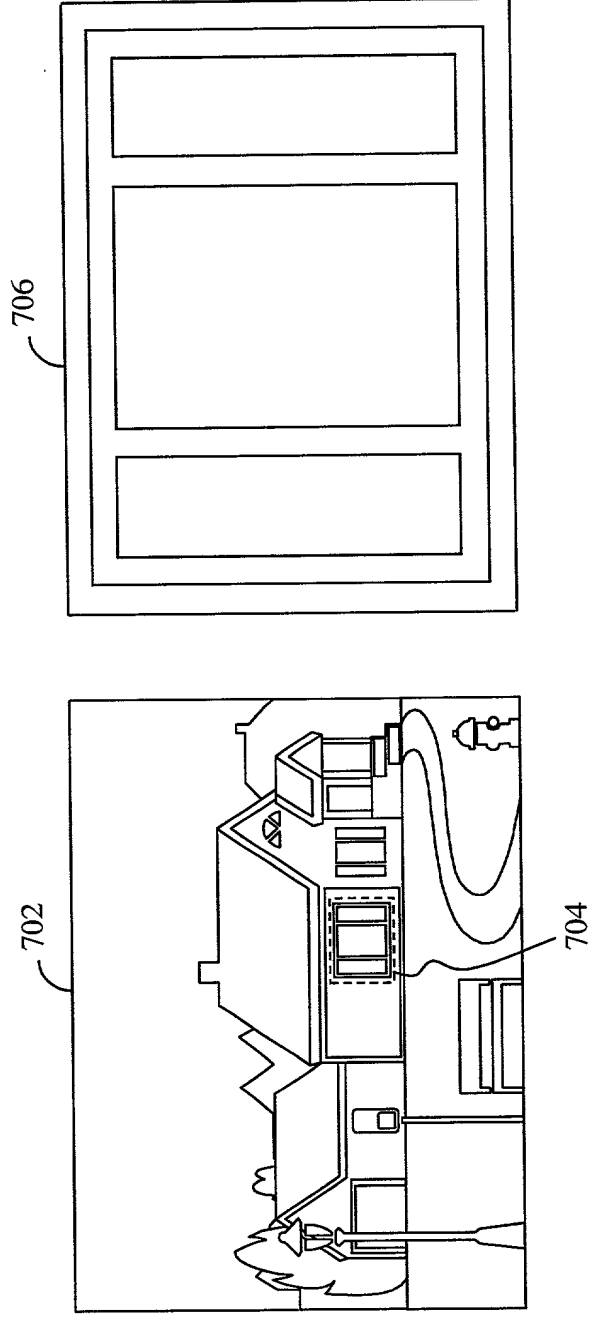


Fig. 7A

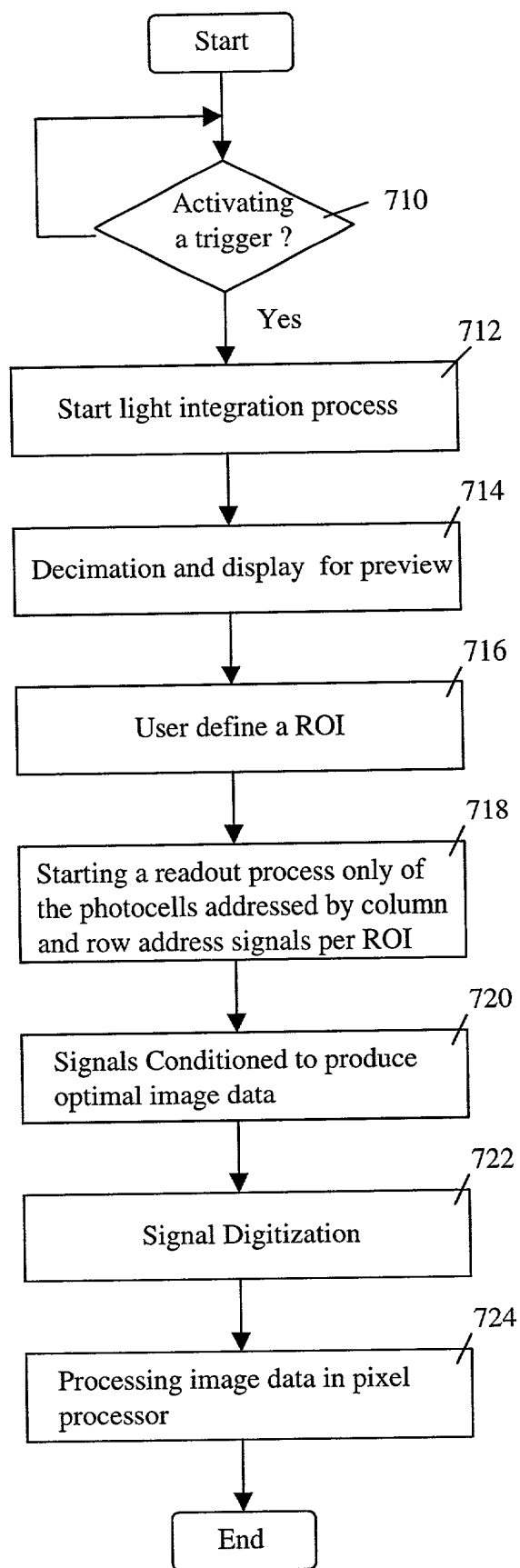


Fig. 7B

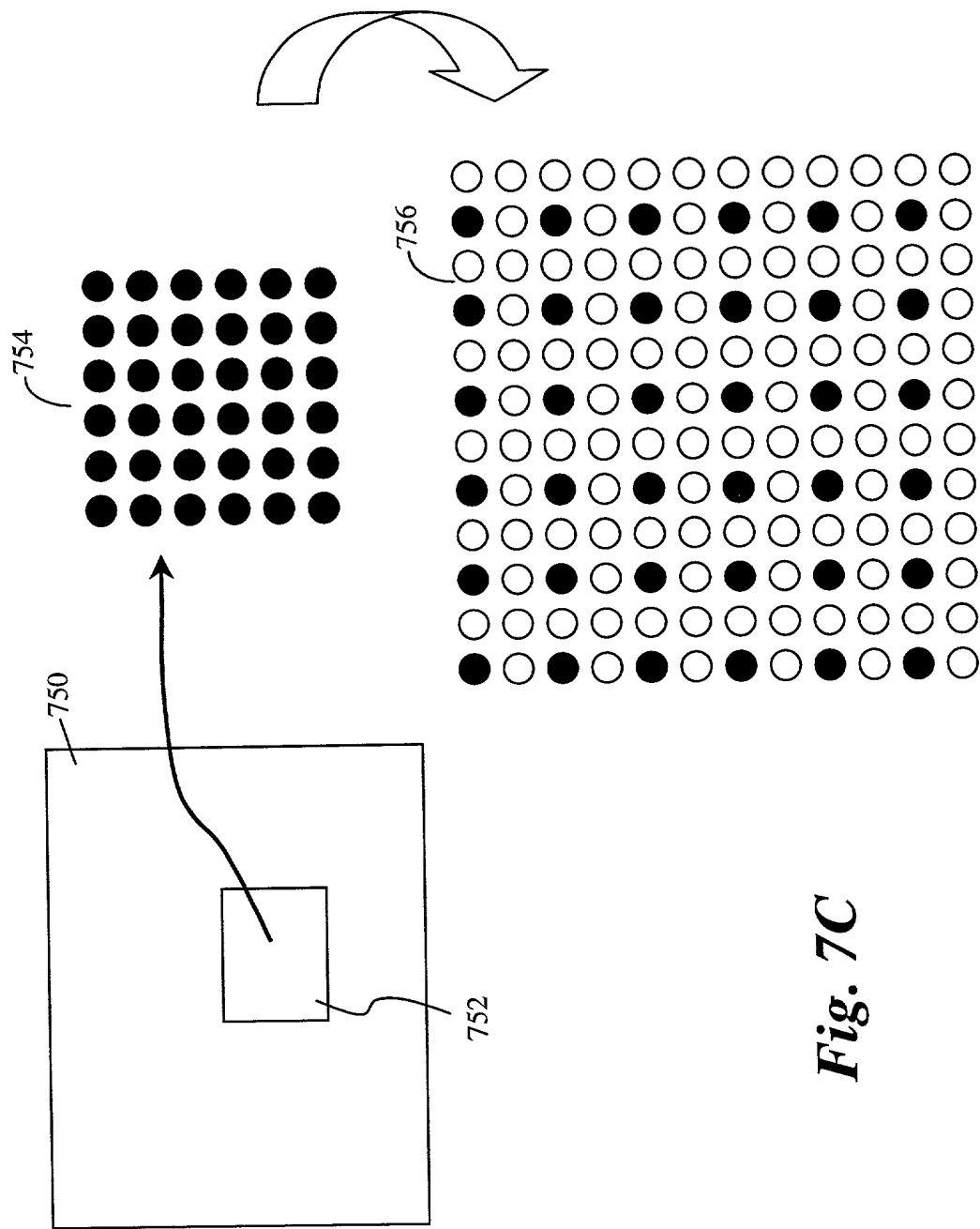


Fig. 7C

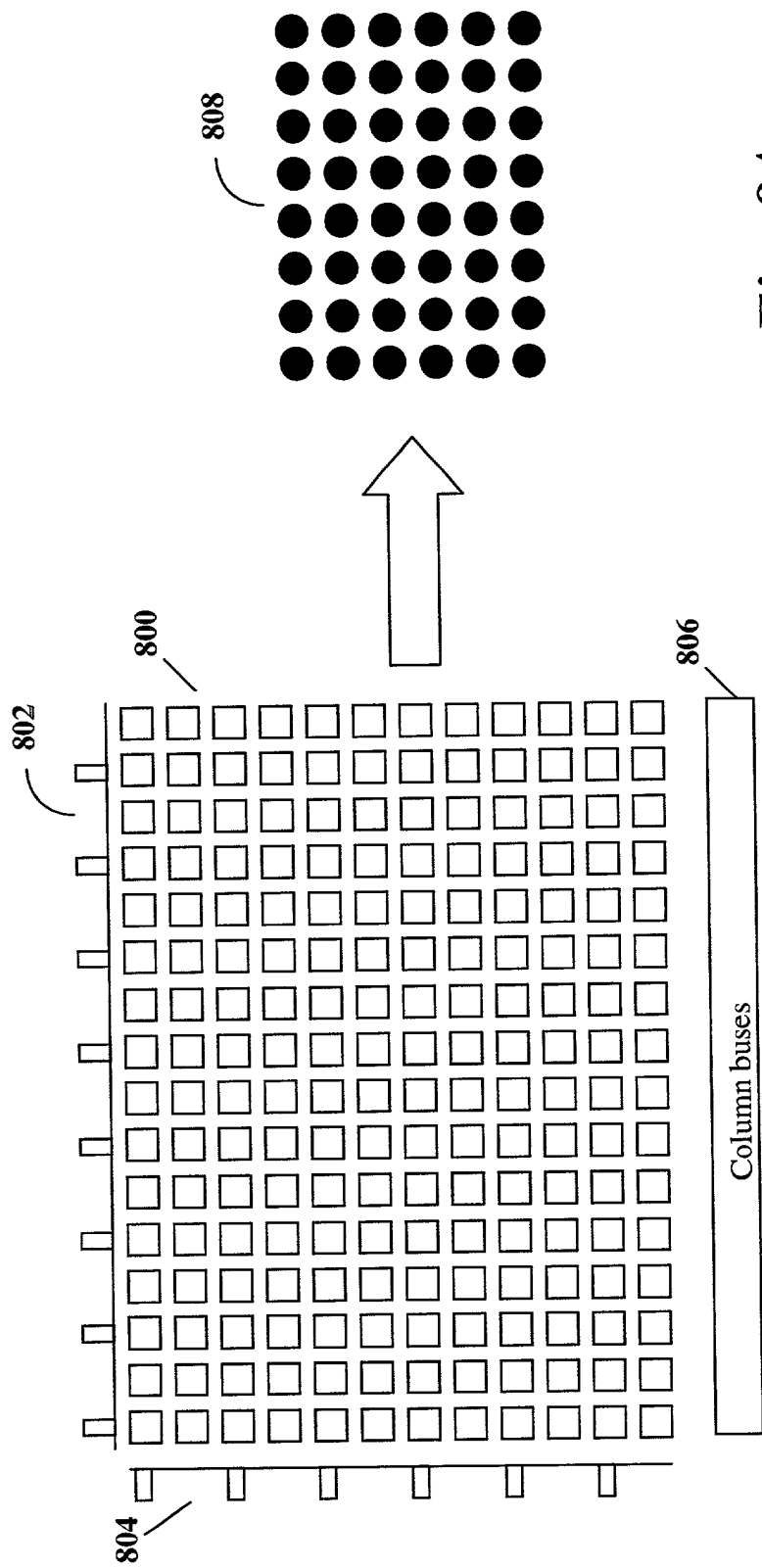


Fig. 8A

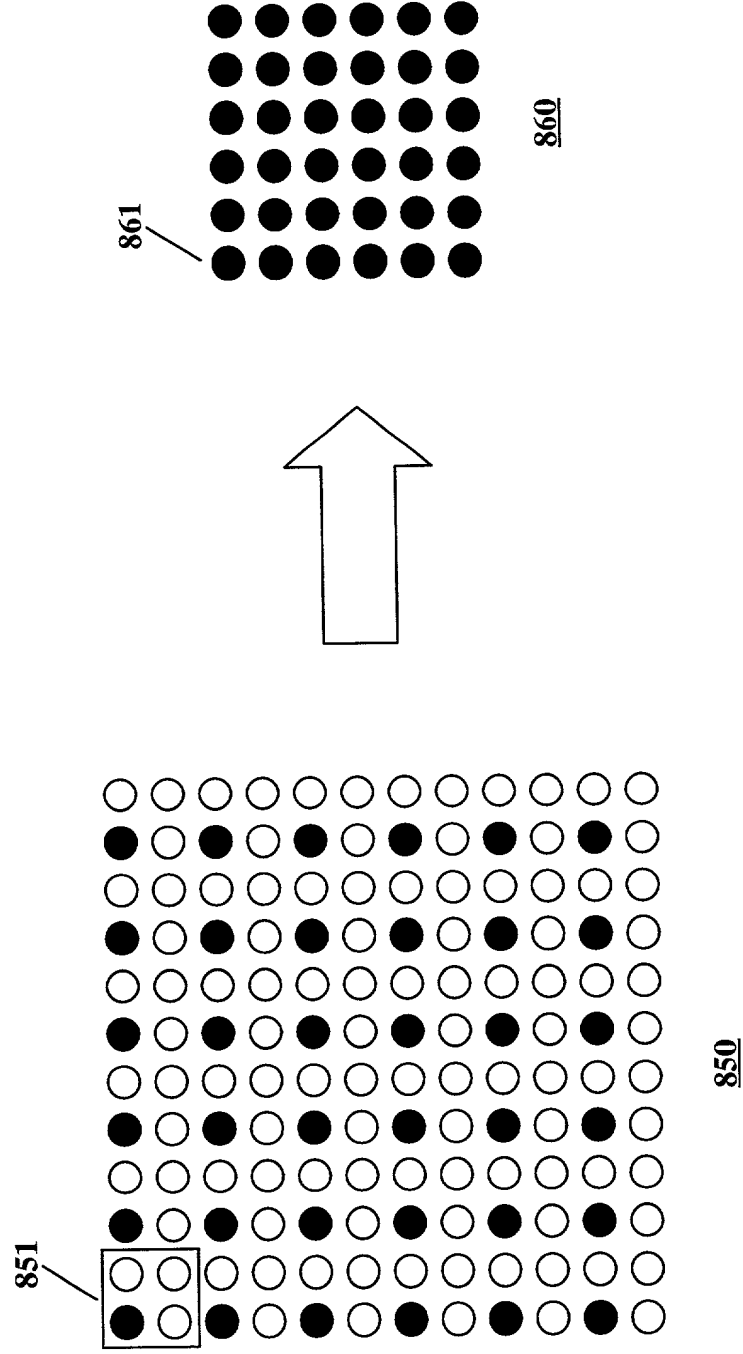


Fig. 8B

Fig. 9A

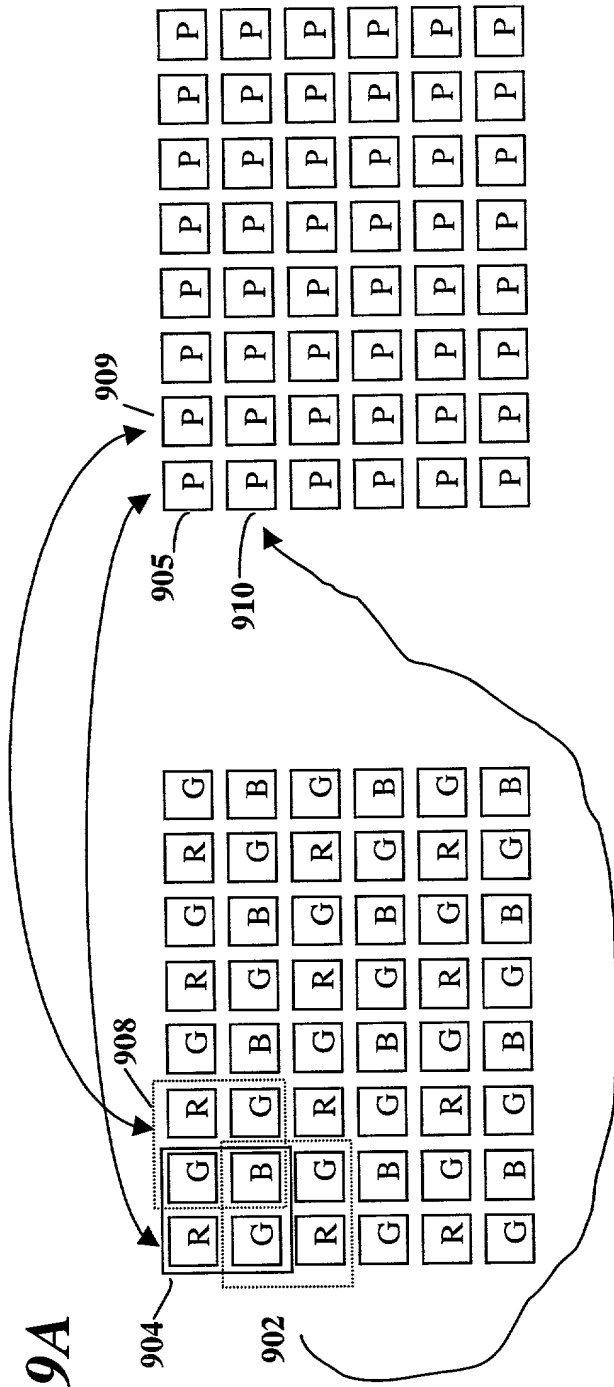
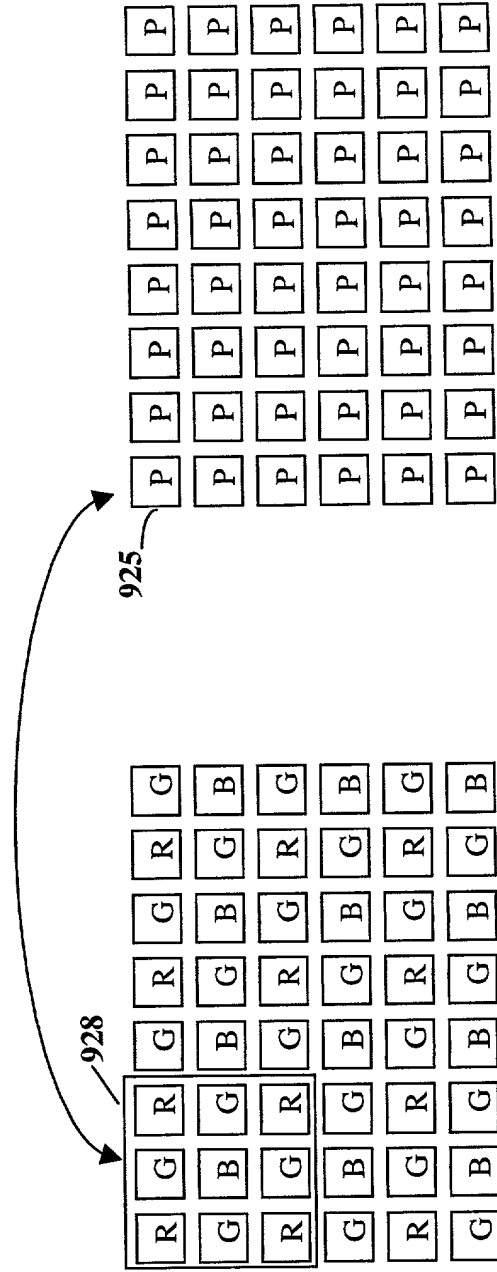


Fig. 9B



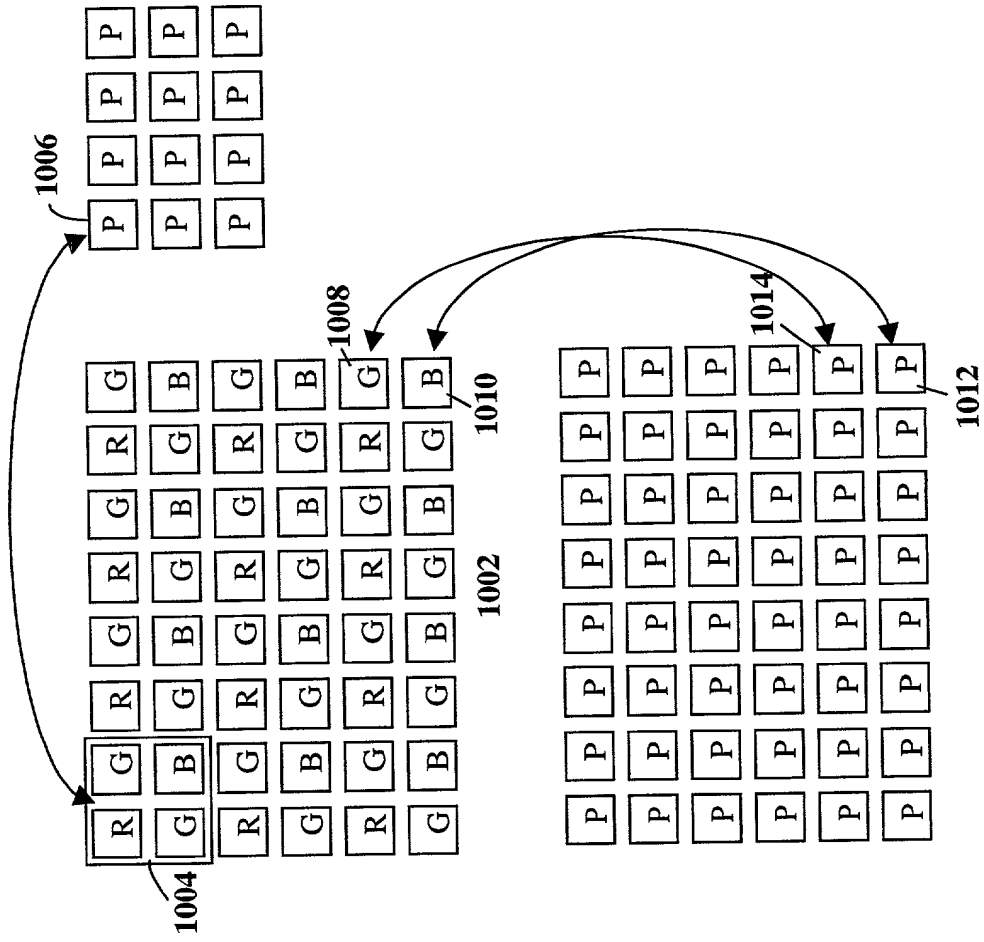


Fig. 10

DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below, next to my name.

I believe I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

Method and Architecture for an Improved CMOS Color Image Sensor

the specification of which

XX is attached hereto.
_____ was filed on _____ as
United States Application Number _____
or PCT International Application Number _____
and was amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119(a)-(d), of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

<u>Prior Foreign Application(s)</u>			<u>Priority Claimed</u>	
<u>Number</u>	<u>Country</u>	<u>Day/Month/Year Filed</u>	<u>Yes</u>	<u>No</u>
_____	_____	_____	_____	_____
_____	_____	_____	_____	_____
_____	_____	_____	_____	_____

I hereby claim the benefit under Title 35, United States Code, Section 119(e) of any United States provisional application(s) listed below:

<u>60/092,533</u>	<u>7/13/98</u>
Application Number	Filing Date
_____	_____
Application Number	Filing Date

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Application Number	Filing Date	Status -- patented, pending, abandoned

Application Number	Filing Date	Status -- patented, pending, abandoned

I hereby appoint the persons listed on Appendix A hereto (which is incorporated by reference and a part of this document) as my respective patent attorneys and patent agents, with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith.

Send correspondence to Dag H. Johansen, **BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP, 12400 Wilshire Boulevard 7th Floor, Los Angeles, California 90025** and direct telephone calls to Dag H. Johansen, (408) 720-8598.
(Name of Attorney or Agent)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of Sole/First Inventor Kevin E. Brehmer

Inventor's Signature _____ Date _____

Residence Morgan Hill, CA _____ Citizenship U.S.A. _____
(City, State) (Country)

Post Office Address 725 Barrett Avenue _____
Morgan Hill, CA 95037 _____

Full Name of Second/Joint Inventor Rudolph A. Widemann

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____
(City, State) (Country)

Post Office Address _____

APPENDIX A

William E. Alford, Reg. No. 37,764; Farzad E. Amini, Reg. No. P42,261; Aloysius T. C. AuYeung, Reg. No. 35,432; Amy M. Armstrong, Reg. No. 42,265; William Thomas Babbitt, Reg. No. 39,591; Carol F. Barry, Reg. No. 41,600; Jordan Michael Becker, Reg. No. 39,602; Bradley J. Bereznak, Reg. No. 33,474; Michael A. Bernadicou, Reg. No. 35,934; Roger W. Blakely, Jr., Reg. No. 25,831; Gregory D. Caldwell, Reg. No. 39,926; Yong S. Choi, Reg. No. P43,324; Thomas M. Coester, Reg. No. 39,637; Michael Anthony DeSanctis, Reg. No. 39,957; Daniel M. De Vos, Reg. No. 37,813; Robert Andrew Diehl, Reg. No. 40,992; Tarek N. Fahmi, Reg. No. 41,402; James Y. Go, Reg. No. 40,621; Dinu Gruia, Reg. No. P42,996; David R. Halvorson, Reg. No. 33,395; Willmore F. Holbrow III, Reg. No. P41,845; George W. Hoover II, Reg. No. 32,992; Eric S. Hyman, Reg. No. 30,139; Dag H. Johansen, Reg. No. 36,172; William W. Kidd, Reg. No. 31,772; Michael J. Mallie, Reg. No. 36,591; Andre L. Marais, under 37 C.F.R. § 10.9(b); Paul A. Mendonsa, Reg. No. 42,879; Darren J. Milliken, Reg. No. 42,004; Thinh V. Nguyen, Reg. No. 42,034; Dennis A. Nicholls, Reg. No. 42,036; Kimberley G. Nobles, Reg. No. 38,255; Daniel E. Ovanezian, Reg. No. 41,236; Babak Redjaian, Reg. No. 42,096; James H. Salter, Reg. No. 35,668; William W. Schaal, Reg. No. 39,018; James C. Scheller, Reg. No. 31,195; Anand Sethuraman, Reg. No. P43,351; Charles E. Shemwell, Reg. No. 40,171; Jeffrey Sam Smith, Reg. No. 39,377; Maria McCormack Sobrino, Reg. No. 31,639; Stanley W. Sokoloff, Reg. No. 25,128; Judith A. Szepesi, Reg. No. 39,393; Vincent P. Tassinari, Reg. No. 42,179; Edwin H. Taylor, Reg. No. 25,129; George G. C. Tseng, Reg. No. 41,355; Joseph A. Twarowski, Reg. No. 42,191; Lester J. Vincent, Reg. No. 31,460; Glenn E. Von Tersch, Reg. No. 41,364; John Patrick Ward, Reg. No. 40,216; Stephen Warhola, Reg. No. 43,237; Charles T. J. Weigell, Reg. No. 43,398; Kirk D. Williams, Reg. No. 42,229; Steven D. Yates, Reg. No. 42,242; Ben J. Yorks, Reg. No. 33,609; and Norman Zafman, Reg. No. 26,250; my patent attorneys, and James A. Henry, Reg. No. 41,064; my patent agent, of BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP, with offices located at 12400 Wilshire Boulevard, 7th Floor, Los Angeles, California 90025, telephone (310) 207-3800, and James R. Thein, Reg. No. 31,710, my patent attorney.

APPENDIX B

Title 37, Code of Federal Regulations, Section 1.56 Duty to Disclose Information Material to Patentability

(a) A patent by its very nature is affected with a public interest. The public interest is best served, and the most effective patent examination occurs when, at the time an application is being examined, the Office is aware of and evaluates the teachings of all information material to patentability. Each individual associated with the filing and prosecution of a patent application has a duty of candor and good faith in dealing with the Office, which includes a duty to disclose to the Office all information known to that individual to be material to patentability as defined in this section. The duty to disclose information exists with respect to each pending claim until the claim is cancelled or withdrawn from consideration, or the application becomes abandoned. Information material to the patentability of a claim that is cancelled or withdrawn from consideration need not be submitted if the information is not material to the patentability of any claim remaining under consideration in the application. There is no duty to submit information which is not material to the patentability of any existing claim. The duty to disclose all information known to be material to patentability is deemed to be satisfied if all information known to be material to patentability of any claim issued in a patent was cited by the Office or submitted to the Office in the manner prescribed by §§1.97(b)-(d) and 1.98. However, no patent will be granted on an application in connection with which fraud on the Office was practiced or attempted or the duty of disclosure was violated through bad faith or intentional misconduct. The Office encourages applicants to carefully examine:

(1) Prior art cited in search reports of a foreign patent office in a counterpart application, and

(2) The closest information over which individuals associated with the filing or prosecution of a patent application believe any pending claim patentably defines, to make sure that any material information contained therein is disclosed to the Office.

(b) Under this section, information is material to patentability when it is not cumulative to information already of record or being made of record in the application, and

(1) It establishes, by itself or in combination with other information, a prima facie case of unpatentability of a claim; or

(2) It refutes, or is inconsistent with, a position the applicant takes in:

(i) Opposing an argument of unpatentability relied on by the Office, or

(ii) Asserting an argument of patentability.

A prima facie case of unpatentability is established when the information compels a conclusion that a claim is unpatentable under the preponderance of evidence, burden-of-proof standard, giving each term in the claim its broadest reasonable construction consistent with the specification, and before any consideration is given to evidence which may be submitted in an attempt to establish a contrary conclusion of patentability.

(c) Individuals associated with the filing or prosecution of a patent application within the meaning of this section are:

(1) Each inventor named in the application;

(2) Each attorney or agent who prepares or prosecutes the application; and

(3) Every other person who is substantively involved in the preparation or prosecution of the application and who is associated with the inventor, with the assignee or with anyone to whom there is an obligation to assign the application.

(d) Individuals other than the attorney, agent or inventor may comply with this section by disclosing information to the attorney, agent, or inventor.